

ISL78610EVKIT1Z

Evaluation Kit User Guide

UG077
Rev 1.00
October 21, 2016

Description

The ISL78610EVKIT1Z is a kit that facilitates testing of the [ISL78610](#) Li-ion battery pack analog front-end ICs. The ISL78610 monitors cell voltage and temperature. It converts the cell voltages and temperatures to 14-bit digital values, provides cell balance control, and provides significant fault detection. The ISL78610 also contains daisy chain hardware to provide robust, redundant, board-to-board communications.

The evaluation kit can be used as a stand-alone monitor or combined with additional boards to create a daisy chained application. One board, operating alone, allows testing of up to 12-cell series-connected Li-ion battery packs, using a standard USB interface to a PC. Up to 14 boards cascade - with daisy chain communication from board-to-board to test systems with up to 168 cells.

Specifications

This board has been configured and optimized for the following operating conditions:

- $V_{BAT} = 6V$ to $60V$
- V_{BAT} daisy chain = $10V$ to $60V$
- VC_n (for $n = 1$ to 12) = $V(VC_{n-1}) + 5V$
- CB_n (for $n = 1$ to 9) = $V(VC_{n-1}) + 9V$
- CB_n (for $n = 10$ to 12) = $V(VC_n) - 9V$ to $V(VC_n)$
- External inputs ExT1 to ExT4 = $0V$ to $2.5V$ (external temperature measurement thermistors on board)

Key Features

- Supports both stand-alone and daisy chained configurations
- Daisy chaining with both connector only or wire jumper options
- GUI provided export option for generation of detailed register and/or SPI communications log files
- USB dongle runs HID firmware for driver-less enumeration and communications with Windows platforms
- GUI add-in chart generation tool supports real-time graphing, zoom, and export of captured data
- Software provides checksum requirements associated with daisy chain communications
- Evaluation kit includes a "Battery Emulation" power supply board for cell voltage generation

Related Literature

- For a full list of related documents, please visit our website - [ISL78610](#) product page

Ordering Information

PART NUMBER	DESCRIPTION
ISL78610EVKIT1Z	Evaluation Kit for the ISL78610EVAL2Z Rev B

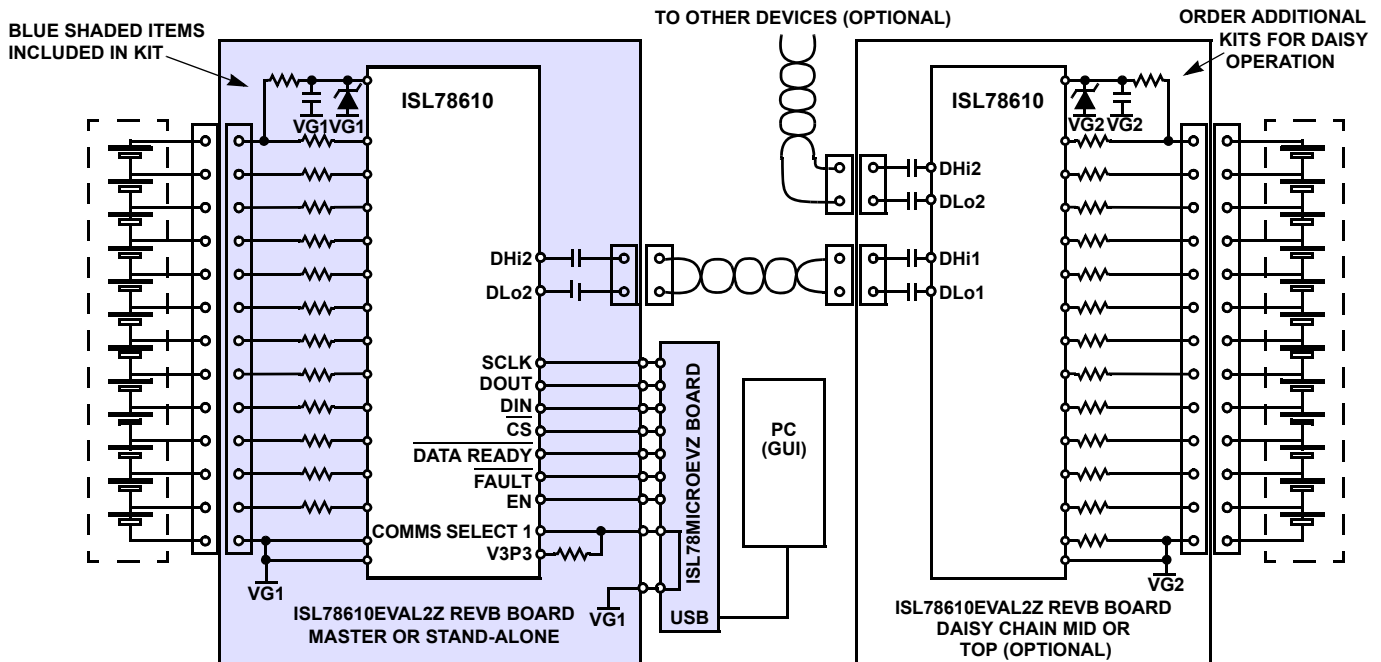


FIGURE 1. TYPICAL APPLICATION

Document Overview

The following are three key portions of this document.

Software Installation

The software is necessary to use this evaluation kit. This section guides you through the installation and verification of both the GUI/Windows software and also the USB enumeration of the HID firmware/dongle device for PC to device(s) communication.

Quick Hardware Setup Guide

This section provides information regarding the connection of the various boards and the settings of the configuration options.

Quick GUI Setup Guide (Using the GUI)

This section steps the user through fundamental use of the GUI software. Enough information is provided to establish and verify communications are working properly and enable the user to observe measurements in real time and export data as well.

Functional Description

The ISL78610EVKIT1Z evaluation kit, coupled with the associated GUI, provides the means to familiarize oneself with the various instructions, capability, and operation of the device. A single ISL78610 Li-ion battery manager IC supervises up to 12 series-connected cells. The part provides accurate monitoring, cell balancing, and extensive system diagnostics functions.

The kit enables the user to activate and data log voltage and temperature measurements. Cell voltages are supplied via a resistor ladder network in the MCB_PS3_Z multicell power supply test board.

The ISL78610 has three cell balancing modes incorporated: Manual Balance mode, Timed Balance mode, and Auto Balance mode. The Auto Balance mode terminates balancing functions when a charge transfer value specified by the host microcontroller has been met. Note: Cell balancing will require the removal of the MCB_PS3_Z multicell power supply test board and attachment of cell devices that are capable of sourcing and sinking current.

The ISL78610 communicates to a host microcontroller via an SPI interface and to other ISL78610 devices using a robust, two-wire daisy chain system. The primary evaluation board provides configuration options that can be set via switches. These are discussed in detail later in this document.

Connecting multiple Intersil boards allows the user to set-up communications and measurement capability of many packs and up to 185 battery cells. However, one should review [“Quick Hardware Setup Guide” on page 4](#). There will be safety concerns as voltage levels increase with multiple packs.

What is Inside

The ISL78610EVKIT1Z evaluation kit contains:

- ISL78610EVAL2Z evaluation board
- MCB_PS3_Z multicell power supply test board
- USB cable, connects PC to evaluation board
- One daisy chain cable

What is Needed

The following instruments will be needed to perform testing:

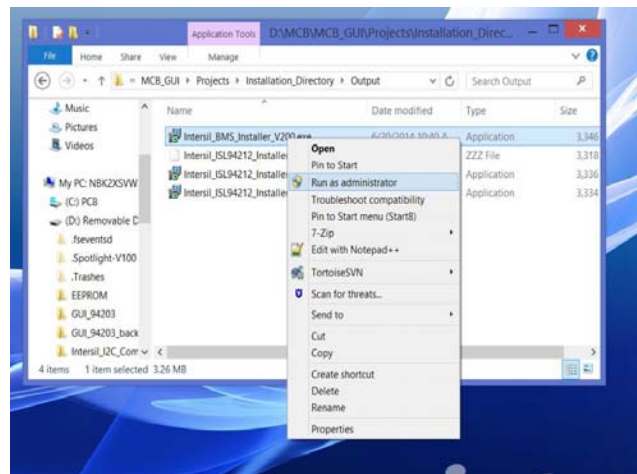
- 60V/1A adjustable power supply
- Wires to connect power supply to MCB_PS3_Z board
- Precision multimeter
- Windows computer with USB port
- One (or two) 24V/1A wall power supplies with 2.1mm power jack - connects to CUI. Includes power jack model PJ-102A. The MCB_PS3_Z board can use these for supply instead of an adjustable supply (optional).
- Oscilloscope (optional)
- Cables and wires (optional)

Software Installation

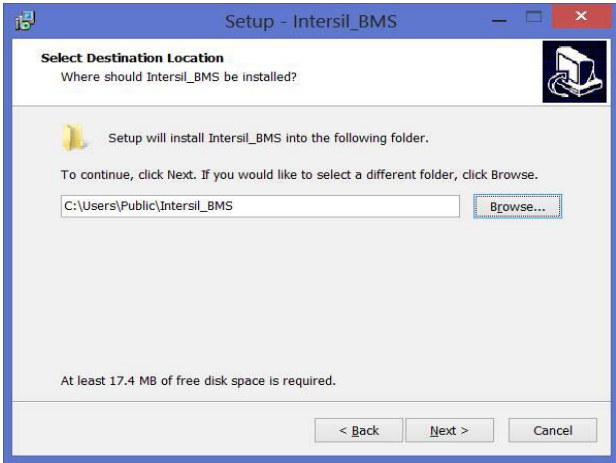
This version of software supports ISL94212, ISL78600, or ISL78610 devices. (For ISL78610 devices, use the ISL78610 setting.) The software has been tested on XP, Win7, and Win8 Platforms.

1. Run the *Intersil_BMS_Vxxx.exe* file. This installs the BMS GUI software to the PC. Depending on your IT department there are a couple of items to address when performing an installation.

Select “Run As Administrator” option when available (right click in installation program)



When setting up project installation and shortcut paths, consider using Users\Public instead of program directory.



2. Connecting the Evaluation board will result in automatic USB Enumeration under the Human Interface section of the Windows device manager.

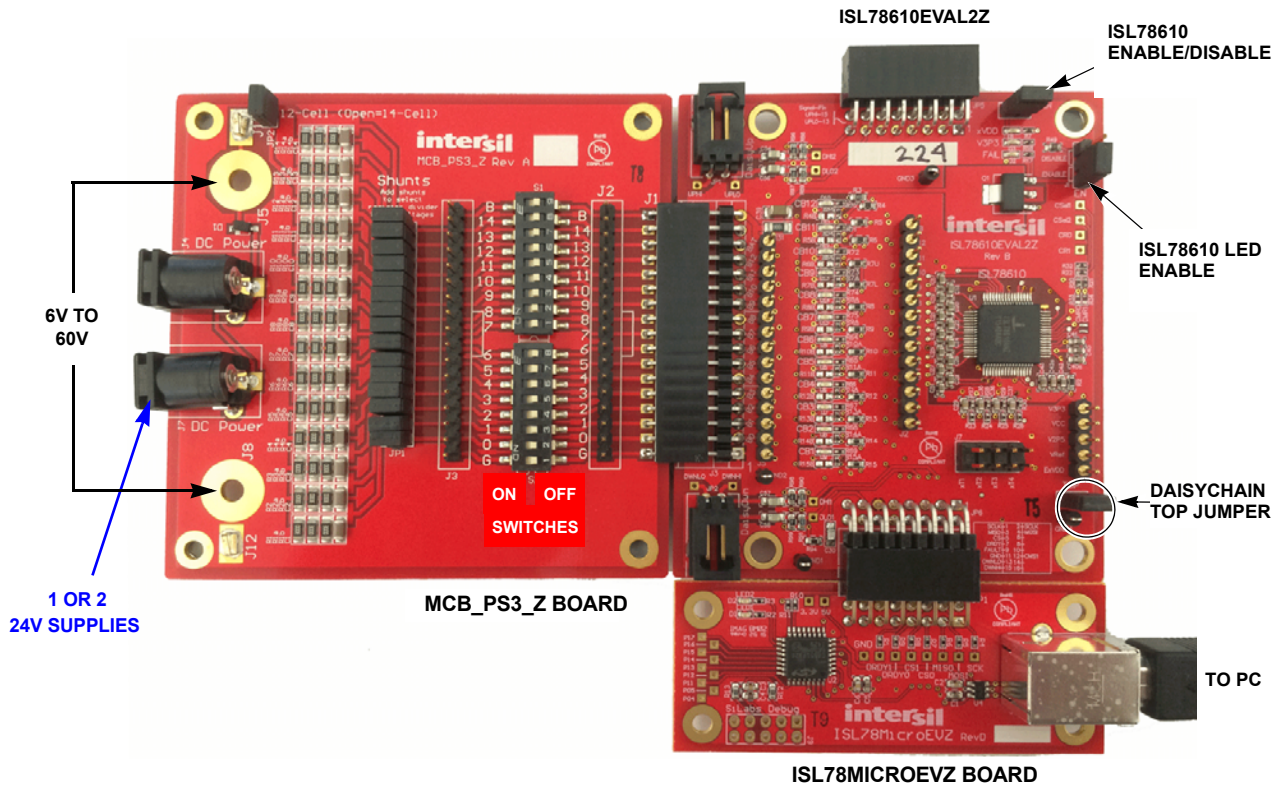
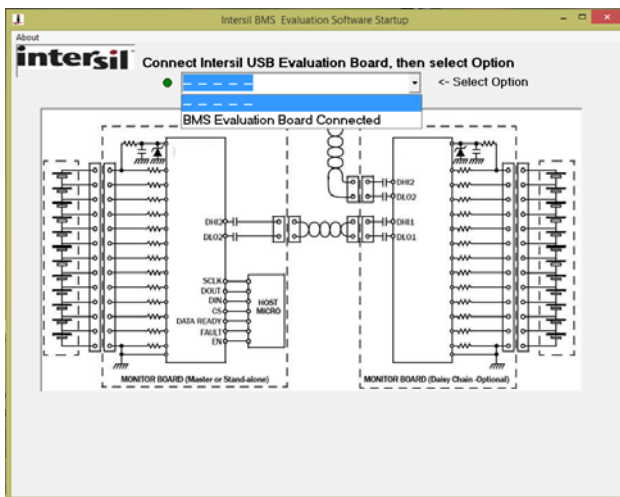


FIGURE 2. ISL78610EVKIT1Z REVB SINGLE BOARD SETUP

Quick Hardware Setup Guide

Single Board

- Before connecting the power supply to the boards, set the power supply voltage to 39.6V (3.3V per cell). If there are fewer cells being tested, reduce the power supply voltage such that it equals 3.3V times the number of cells.
- Connect and check the power supply to the MCB_PS3_Z board. The positive terminal is J5/J11 and the negative terminal is J8/J12. Check that the voltages on the J2 connector are 3.3V from pin to pin. Ground should be on the pin labeled "0" and "G".
If there is no voltage on J2, check that the switches are all set to "ON". Also, make sure that there is a jumper on JP2 of the MCB_PS3_Z board to select the 12-cell option. This puts the proper voltage on the VBAT pin.
- Turn off the power to the power supply.
- Connect ISL78610EVAL2Z connector J4 to the MCB_PS3_Z board connector J1.
- Check the jumpers and switches. Since this is a single board configuration, the ISL78610EVAL2Z board should be configured as follows:
 - EN, LEDEN should contain jumpers.
 - EN should be set to ENABLE.
 - Place a shunt on the "TOP" jumper for single board operation.
- Connect microcontroller board (ISL78MICROEVZ) connector JP1 to the ISL78610EVAL2Z board connector JP6 (see [Figure 2](#)).
- Connect the USB port of the PC to the USB port of the ISL78610EVAL2Z board.
- Run the GUI. A "Startup" screen in the GUI will indicate whether the USB dongle is connected and wait for you to select the evaluation board.



- Turn on the power to the supply and notice that there are two green LEDs (V3P3 and xVDD), indicating the LDO regulators on the ISL78610 are operating.

Once powered, the ISL78610EVAL2Z board voltages at various points should be:

V3P3 = 3.3V \pm 3%

VCC = \sim 3.3V \pm 5% (a little lower than V3P3)

V2P5 = 2.5V \pm 2%

VREF = 2.5005V \pm 0.5mV. (see ["Quick GUI Setup Guide \(Using the GUI\)"](#) on page 8). Use the software to connect the board and read the cell voltages.

- On the GUI, select "Connect". This will bring up a configuration box. Select "Non-Daisy" and click on "OK".
- Compare the voltages at the board input with the readings provided by the GUI. Use a meter to measure each of the cell voltages just after the J3 connector on the ISL78610EVAL2Z board, because the MCB_PS3_Z board may not accurately divide the voltages into equal 3.3V steps. Also, measure the voltage from cell to cell, not cell to ground, to get the best accuracy. The meter reading and the GUI readout voltages should closely match (\pm 5.0mV at 3.3V and room temperature).

Daisy Chain

- Before connecting the power supply to the boards, set the power supply voltage to 39.6V (3.3V per cell). If there are fewer cells being tested, reduce the power supply voltage such that it equals 3.3V times the number of cells.
- Connect the power supply to all MCB_PS3_Z boards in parallel. This is not typical of a battery installation, where the ground of one board is the V_{BAT} of another, but it easily facilitates testing of the communication and allows a safer environment for initial testing.
There should be one MCB_PS3_Z board for every evaluation board. The positive terminal of the MCB_PS3_Z board is J5/J11 and the negative terminal is J8/J12. Check that the voltages on the J3 connectors of all boards are 3.3V from pin to pin. Ground should be on the pin labeled "0" or "GND".



USE CAUTION when connecting the MCB_PS3_Z boards in series, since voltages quickly reach hazardous levels. **BE CAREFUL!**

- Turn off the power to the power supply.
- Connect each ISL78610EVAL2Z board connector J4 to an MCB_PS3_Z board connector J1.
- Connect the daisy chain.
The daisy chain can be connected together directly or with cables, as shown in [Figures 3 and 4](#) on page 7 or using a combination of direct and cable connections. When using twisted pair cables, connect the wires as shown in [Table 1](#) on page 5. (Note: the boards are configured to prevent both direct connection and twisted pair cable connection.)

TABLE 1. DAISY CHAIN CONNECTION

DAISY CHAIN BOARD	ISL78610 DaisyDwn	ISL78610 DaisyUp
Master	NC	Connect to DaisyDwn of board above
Middle	Connect to DaisyUp of board below	Connect to DaisyDwn of board above
Top	Connect to DaisyUp of board below	NC

NOTE: NC = No Connection

6. Check the jumpers and switches on the boards. Since this is a daisy chain configuration, each board should be configured as follows:
 - EN and LEDEN contain jumpers
 - EN should be set to ENABLE
 - Place a shunt on the “TOP” jumper on the top daisy chain board only. There should be no shunt on the “TOP” jumper on the other two boards.
7. Connect microcontroller board (ISL78MICROEVZ) connector JP1 to the master ISL78610EVAL2Z board connector JP6.
8. Connect the USB port of the PC to the USB port of the ISL78MICROEVZ daisy chain master board.
9. Turn on the power to the supply and notice that on each board there are two green LEDs (xVDD and V3P3), indicating the LDO regulators on the ISL78610 are operating.

The voltages at various points (relative to the ground on the board) should be:

- ISL78610 voltages
- VDD = 3.3V \pm 3%
- VCC = \sim 3.3V \pm 5% (a little lower than VDD)
- V2P5 = 2.5V \pm 2%
- VREF = 2.5005V \pm 0.5mV

10. To connect all boards, complete the steps below. Specify “Daisy Chain” and the number of devices in the chain when the configuration screen appears.
11. On the GUI, select “Connect”. This will bring up a configuration box. Select “Daisy Chain” and select the number of daisy chain connected boards. Then click on “OK”.
12. See [“Quick GUI Setup Guide \(Using the GUI\)” on page 8](#). Use the software to read the cell voltages.
13. Compare the voltages at the board input with the readings provided by the GUI. Use a meter to measure the voltages after the J3 connector on the ISL78600EVAL2Z boards, because the MCB_PS3_Z board may not accurately divide the voltages into equal 3.3V steps. Measure the voltage from cell to cell, not cell to ground, to get the best accuracy. The meter reading and the GUI readout voltages should closely match (\pm 2.5mV at 3.3V and room temperature).

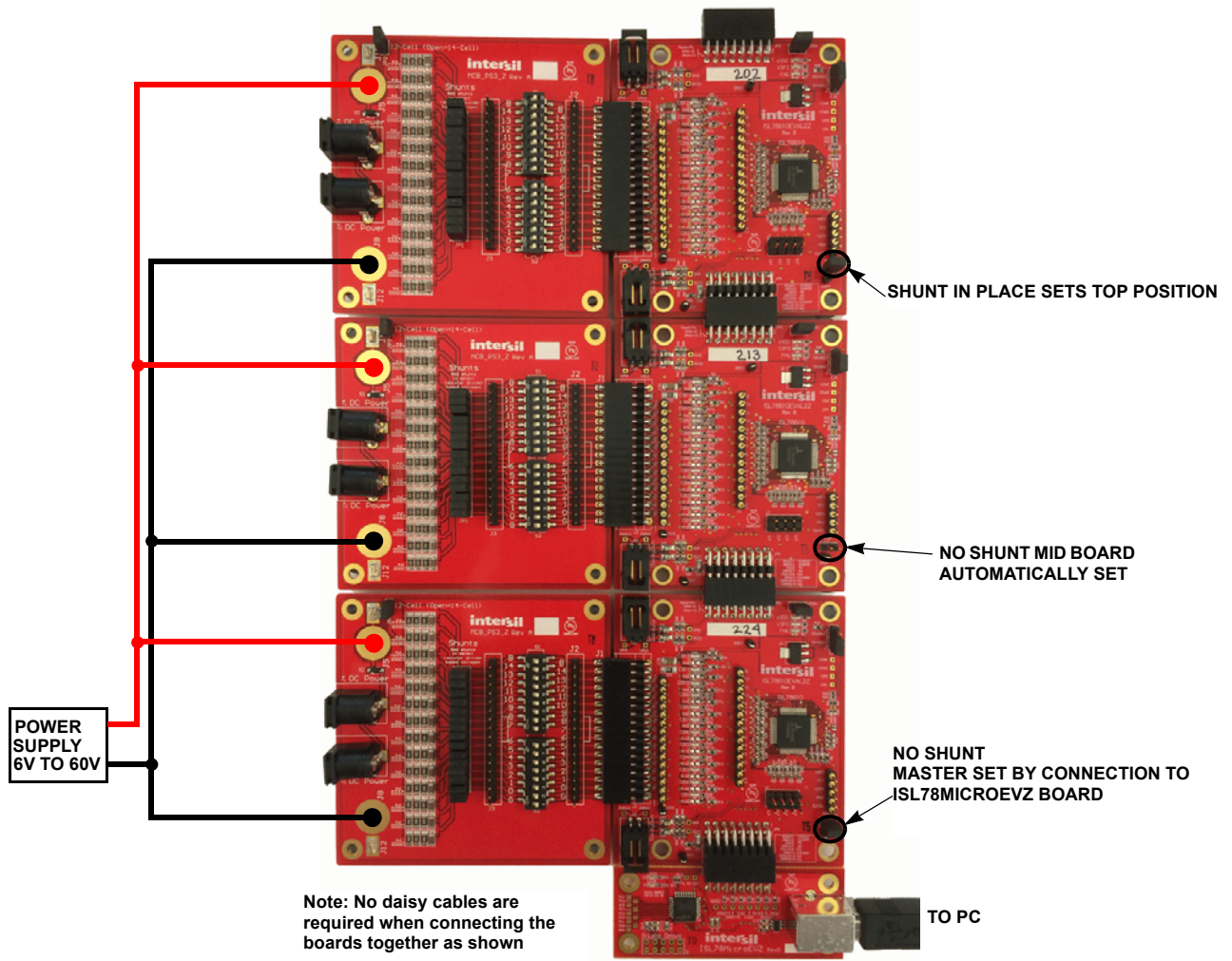


FIGURE 3. ISL78610EVKIT1Z IN 36-CELL DAISY CHAIN CONFIGURATION

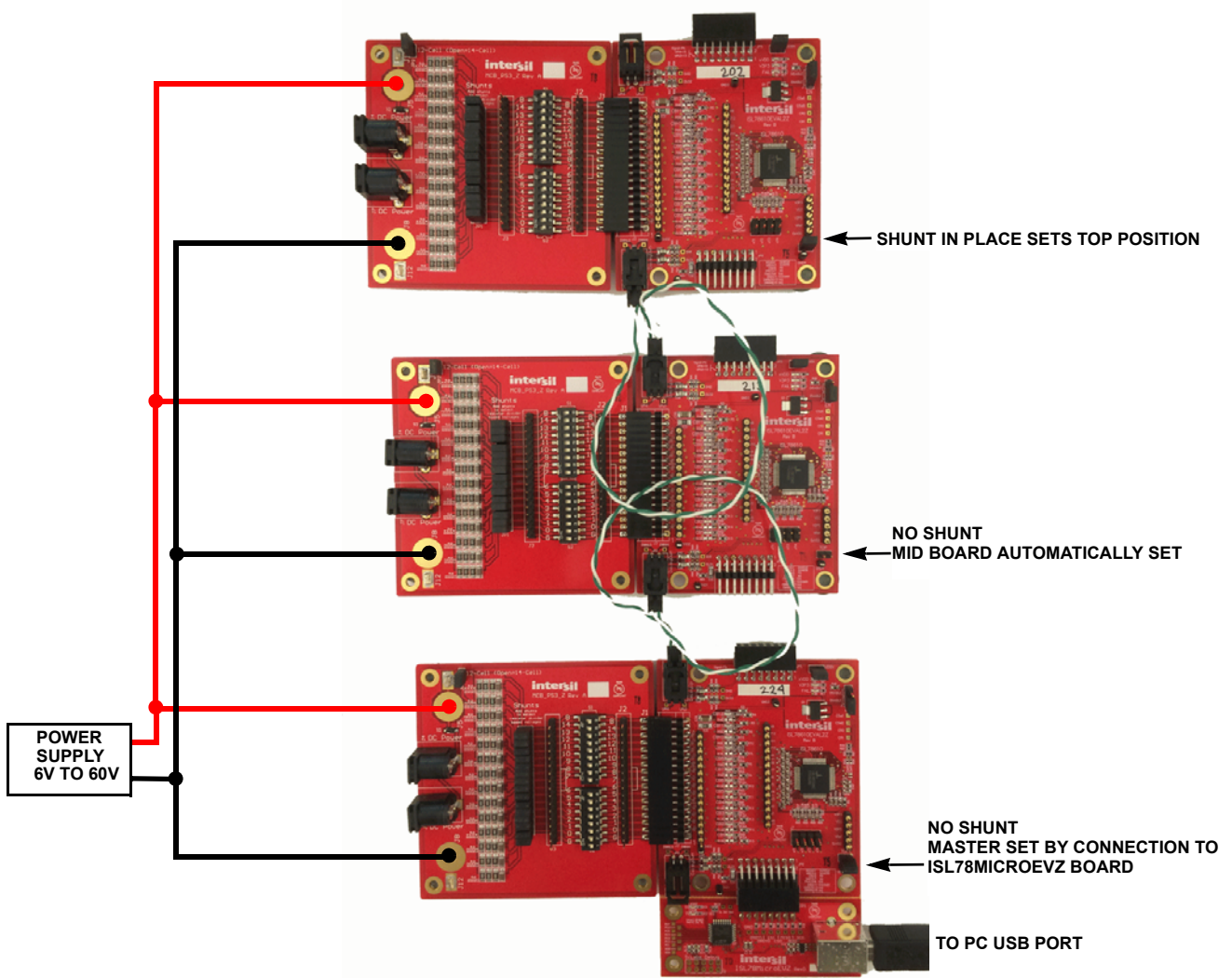
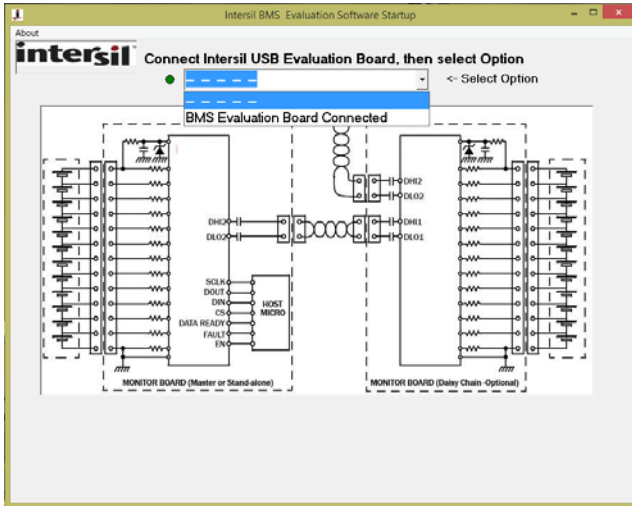


FIGURE 4. ISL78600EVKIT1Z REV B IN 36-CELL CABLE CONNECT DAISY CHAIN CONFIGURATION

Quick GUI Setup Guide (Using the GUI)

1. Once the board is powered up and connected to the PC through the USB cable, start the GUI program.
2. A "Startup" screen in the GUI will wait for you to select the combo box. Click on "BMS evaluation board connected".



3. Open the ISL78600 GUI software. From the Startup screen, the software will take you to the Configuration Screen. See [Figure 6 on page 9](#). For a stand-alone configuration, select "Non-Daisy Chain" in the BMS Configuration Box, then click "OK." For a daisy chain configuration, select "Daisy Chain" in the BMS Configuration Box and select the number of devices in the daisy chain, then click "OK." The GUI will return to the main screen and automatically connect to the system.
4. In a daisy chain configuration, the top bar provides an indication of the boards connected and allows selection of any specific device in the daisy chain. Device 15 selects all devices. Device 0 selects devices that are not yet identified. For a single board, these boxes are not shown.

5. Use the various tabs and buttons to monitor and control the operation of the device.
6. The "Device Commands" buttons along the bottom of the main tab are commands sent to all boards in the system. Thus, selecting "Scan Volts" then "Read Volts" causes all boards to read the cell voltages and temperatures, update the ISL78610 register values, and the GUI display boxes. (Note: these buttons send separate commands to each board. It does not send a "Scan All" or "Read All" command) see [Figure 6](#).
7. At the bottom of the screen are activity logs showing the USB communications and the SPI communications to the master board.
8. To clear fault indications, read the register, then click on each individual bit to change the setting (or write 0 to the register value), then click on Write to send the value to the device. Using the Read Group or Write Group button sends commands to all registers on the page.
9. Use the "Show Chart" button to view various voltages and status in real time (see [Figure 7](#)).

Chart Window

The Charting function of the GUI provides real time viewing of the critical voltages in the battery pack. The chart updates results as long as the GUI is polling. If the GUI stops polling (or there is a communication interruption) the chart maintains the last valid value.

At the end of a sample period, the captured data can be exported to a file that can be loaded into Excel for further analysis by clicking on the "Export" button.

Using the controls at the left of the screen, various charts can be turned off and the specific cells being monitored can be chosen. At this time, the cell voltages of only two packs can be monitored on one screen and only the temperatures of board 1 can be monitored.

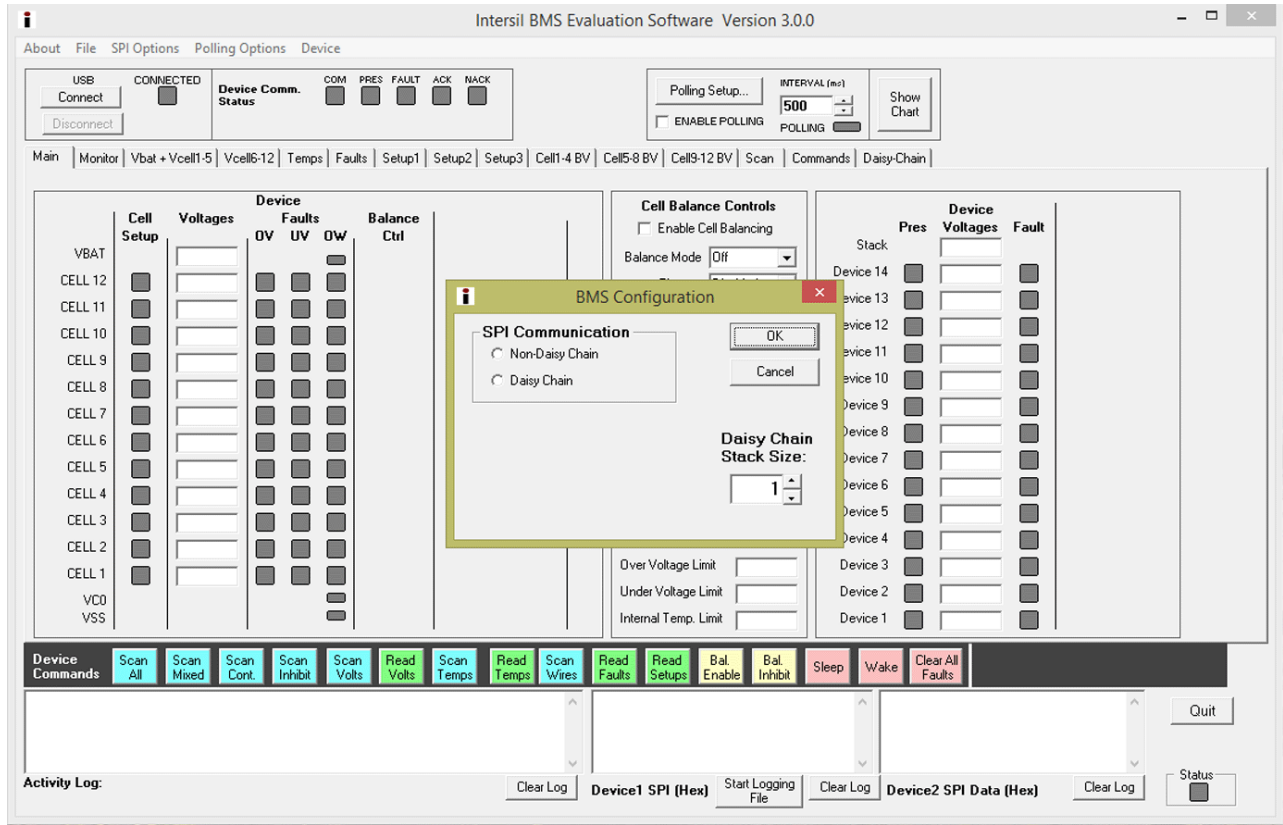


FIGURE 5. GUI CONFIGURATION SELECT

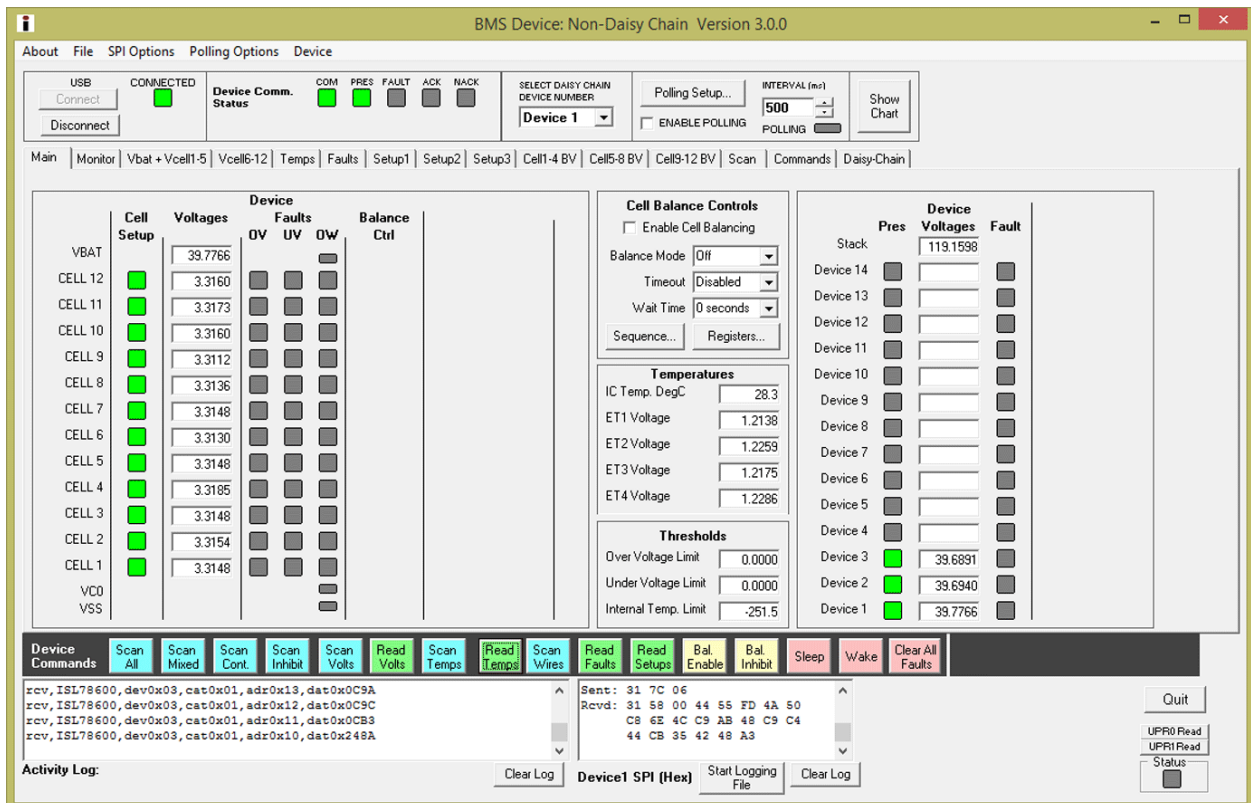


FIGURE 6. MAIN GUI WINDOW - THREE CASCADED DEVICES

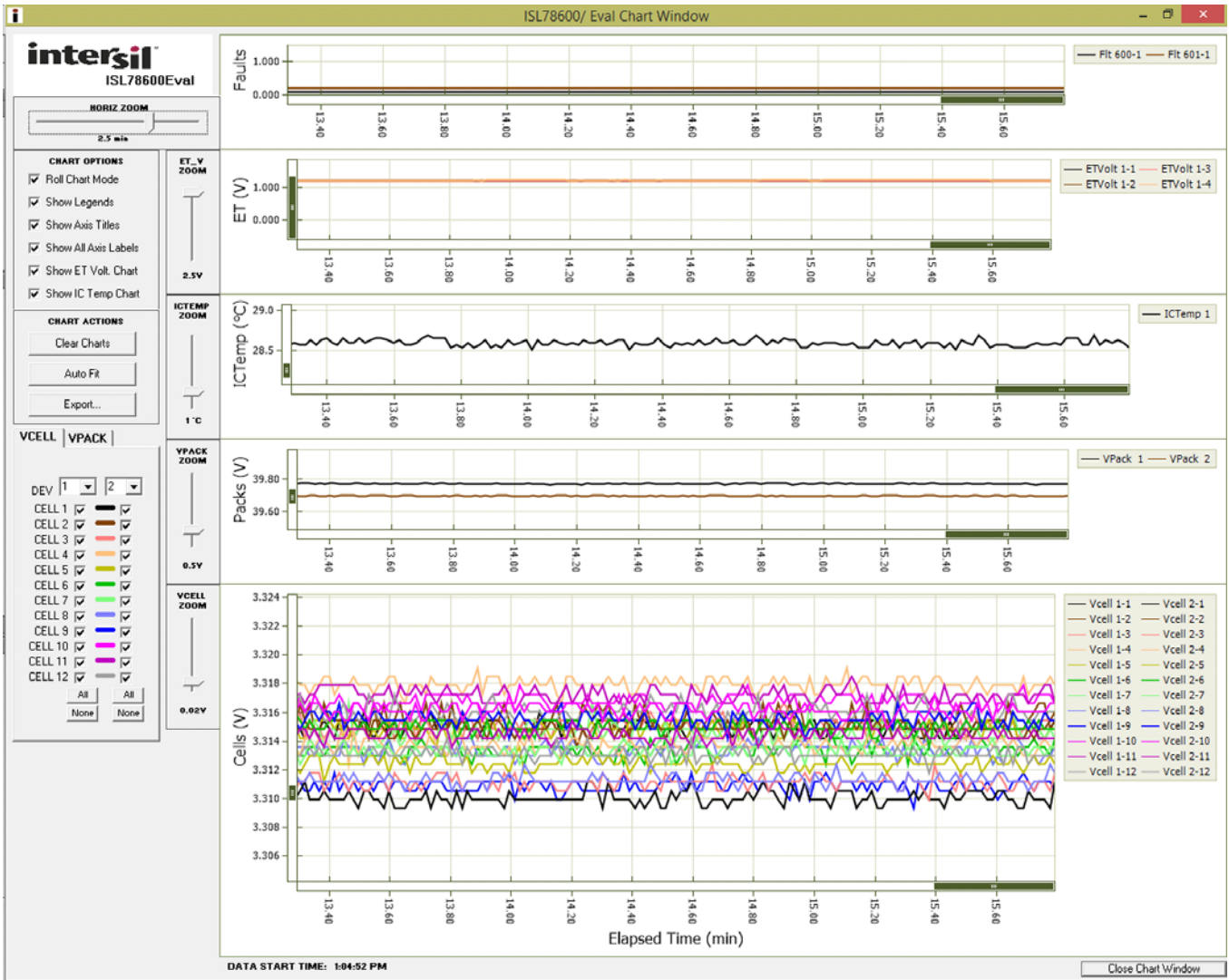


FIGURE 7. CHART WINDOW

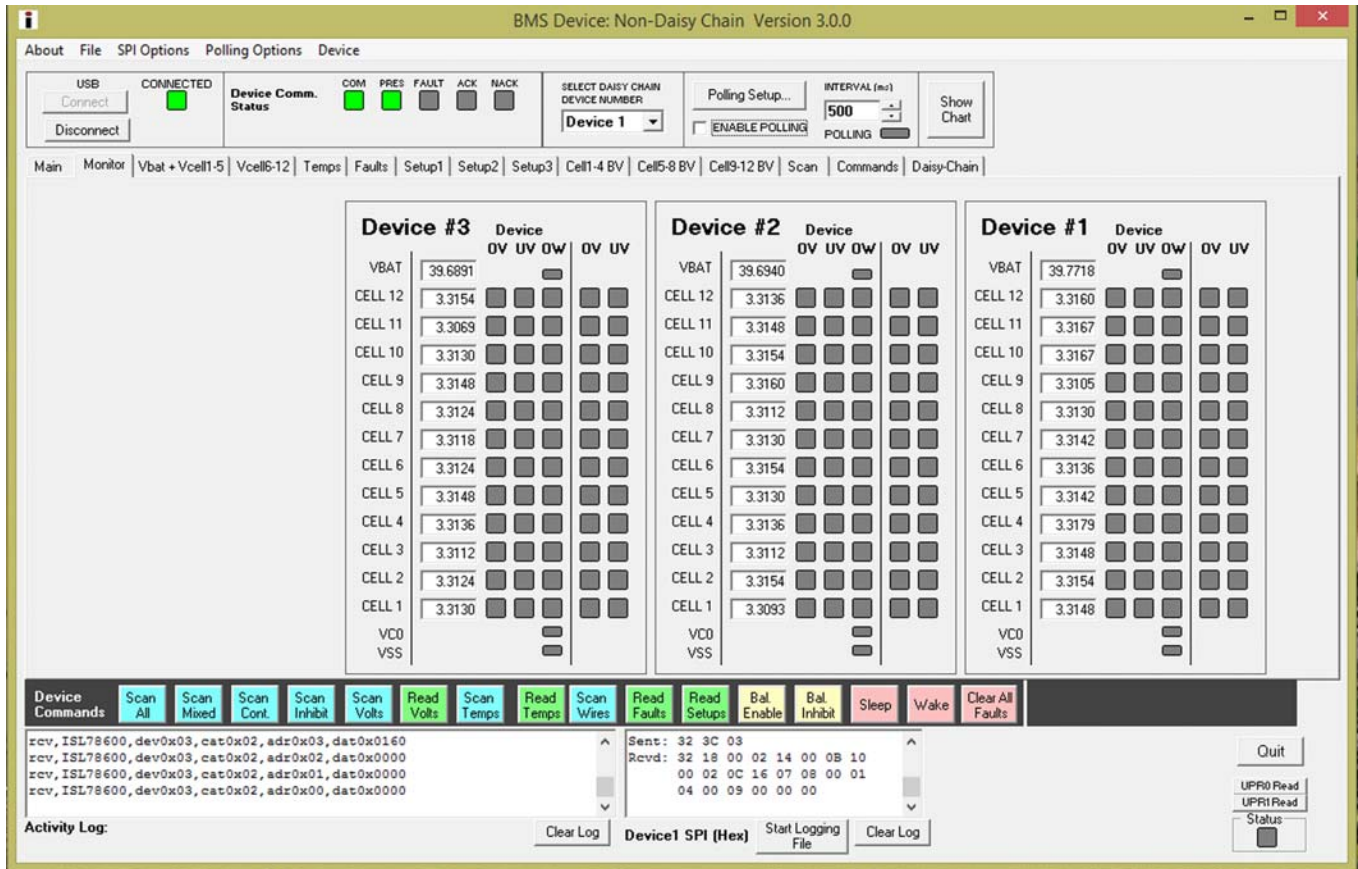


FIGURE 8. MONITOR TAB

Monitor Tab

The Monitor tab (Figure 8) shows the voltages and status of the first four boards in the daisy chain. At this time, it is not possible to select the results for any other boards in the stack. Individual boards can be monitored in the main window, one board at a time.

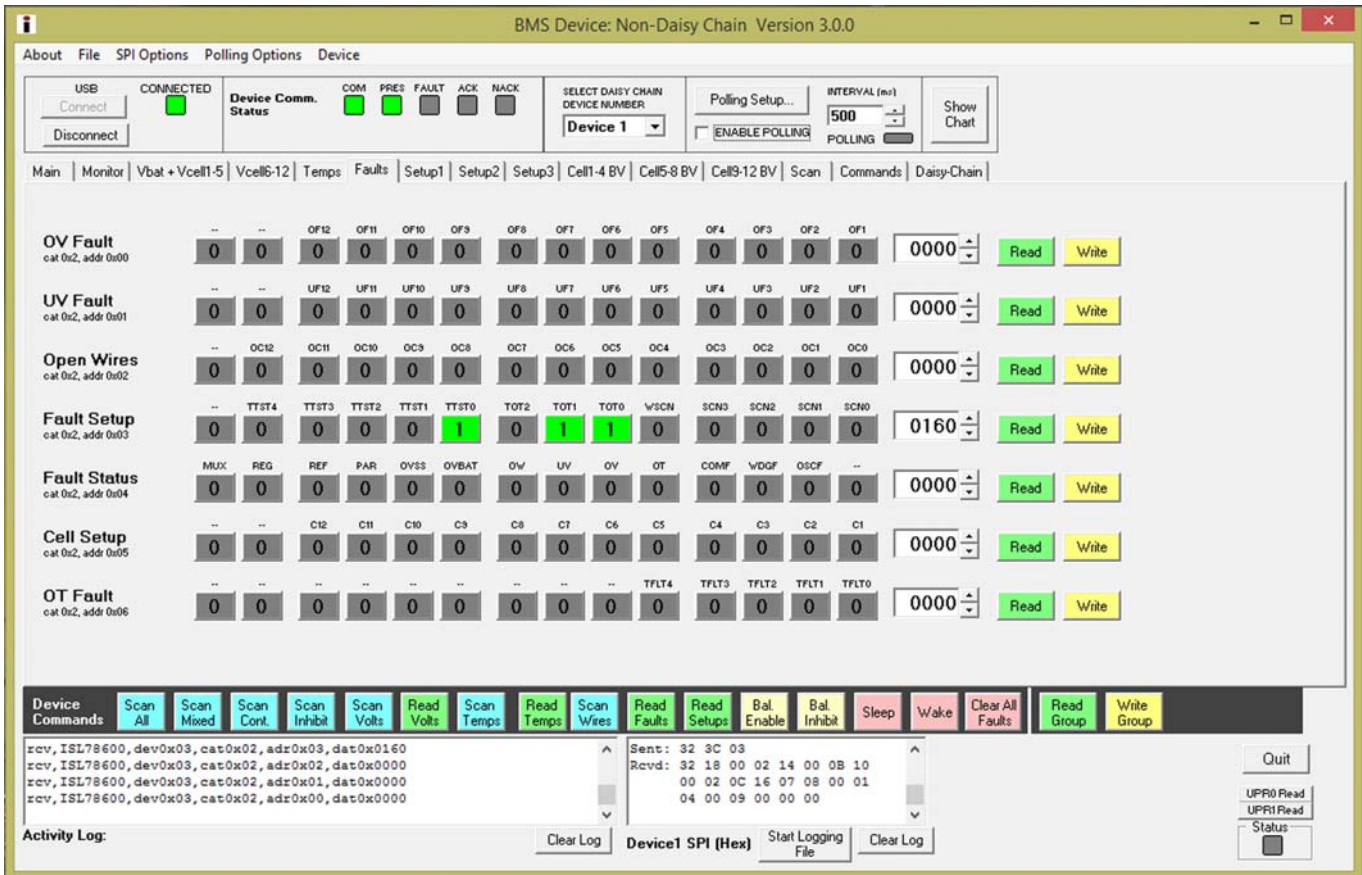


FIGURE 9. FAULT REGISTERS

Fault Tab

The Fault tab (Figure 9) shows the status of the Fault register of the selected device. To update the display, click on the individual “Read” buttons at the end of each fault register, or click on the “Read Group” button on the Device Command line (toward the bottom of the window) to read all registers in the Tab.

To clear a bit, click on the bit that is set (or write a 0 in the box at the right to reset all bits). Then, click on the “Write” button at the end of each fault register, or click on the “Write Group” button on the device command line to write to all of the registers in the tab.



FIGURE 10. COMMANDS

Command Tab

The Command tab allows individual commands to be sent to any device in the stack (or all devices, if device 15 is chosen.) This tab includes a Raw Message Sender and CRC4 calculator. By entering in the Device Address, Data Type, Data Address, and Data the GUI calculates the CRC4 value and shows the resulting Encoded command. This command can then be sent to the chosen device. The image in [Figure 10](#) shows the command for SLEEP.

ISL78600EVAL2Z Evaluation Board

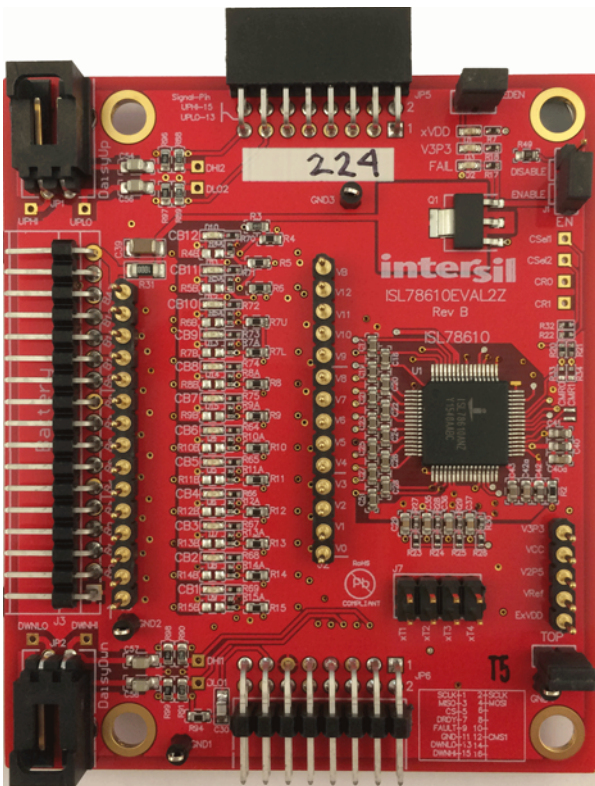


FIGURE 11. TOP VIEW

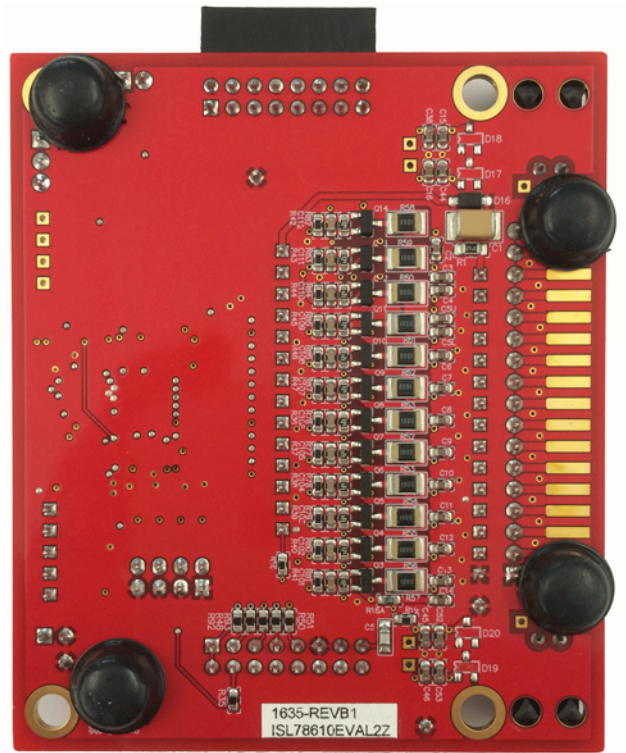


FIGURE 12. BOTTOM VIEW

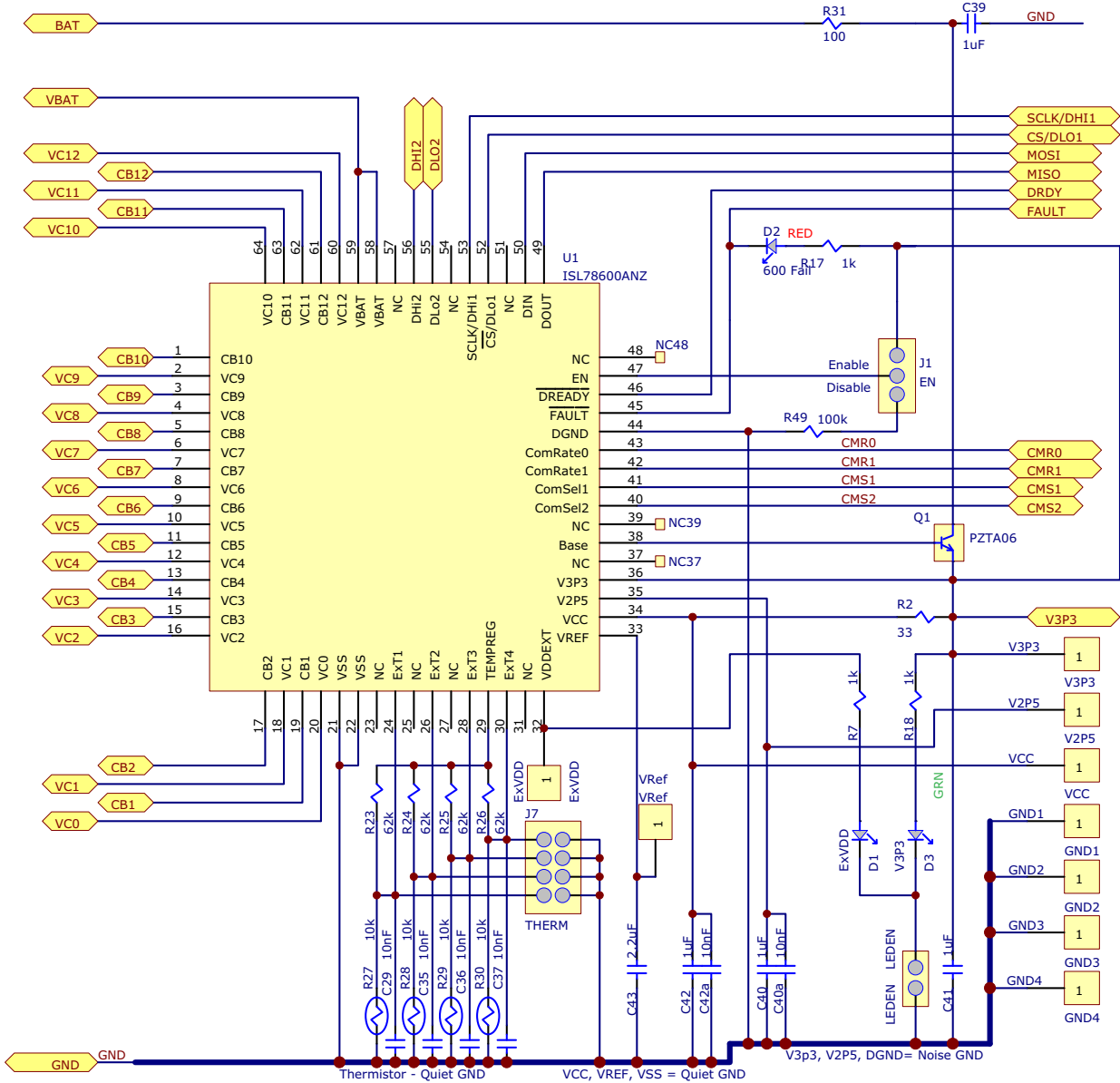


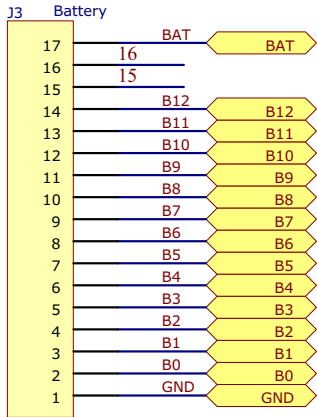
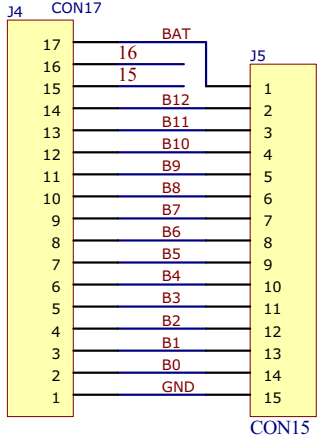
FIGURE 13. ISL78610EVAL2Z REV B BOARD AFE SCHEMATIC

Schematics

Schematics (Continued)

N-channel FETs (x9)
DMN6140L Diodes, Inc
DMN6075S Diodes, Inc
SSM3K318R Toshiba

P-Channel FETs (x3)
FDN5618PTR Fairchild
CPH3351 On Semi
RQ5L015SPTL Rohm



J3 = Sullins, P/N: STC025YAN
Mates to PCB Socket, Sullins P/N: NP7C171LGBN-RC
or, Mates to cable connector, Molex P/N: 0050579017
or, Mates to cable connector, TE Connectivity P/N: 3-87499-2

J3 = TE Connectivity (R/A connector), P/N: 6-104935-6
Mates to cable connector: TE Connectivity P/N: 1-104257-6

Cable wire 3M 8124 Series
Cable Pins: TE Connectivity: P/N: 1-104480-7
Cable Pins: Molex: P/N: 0016020086

Populate R4A to R15A to monitor after cell balance resistor (default)
Populate R4B to R15B to monitor directly at PCB (battery) connection

Do Not Populate both.

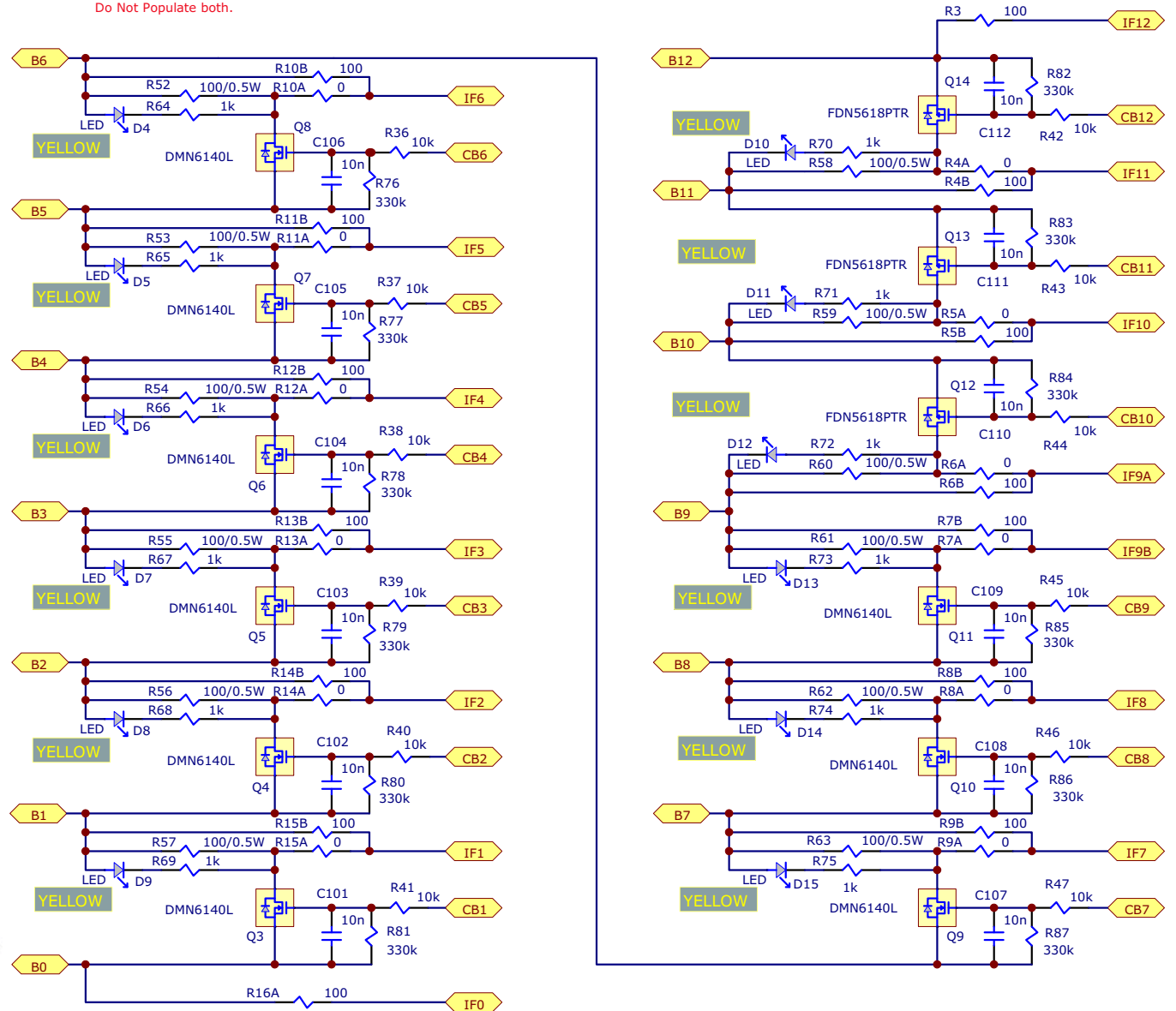


FIGURE 14. ISL78610EVAL2Z REV B BOARD CELL BALANCE SCHEMATIC

Schematics (Continued)

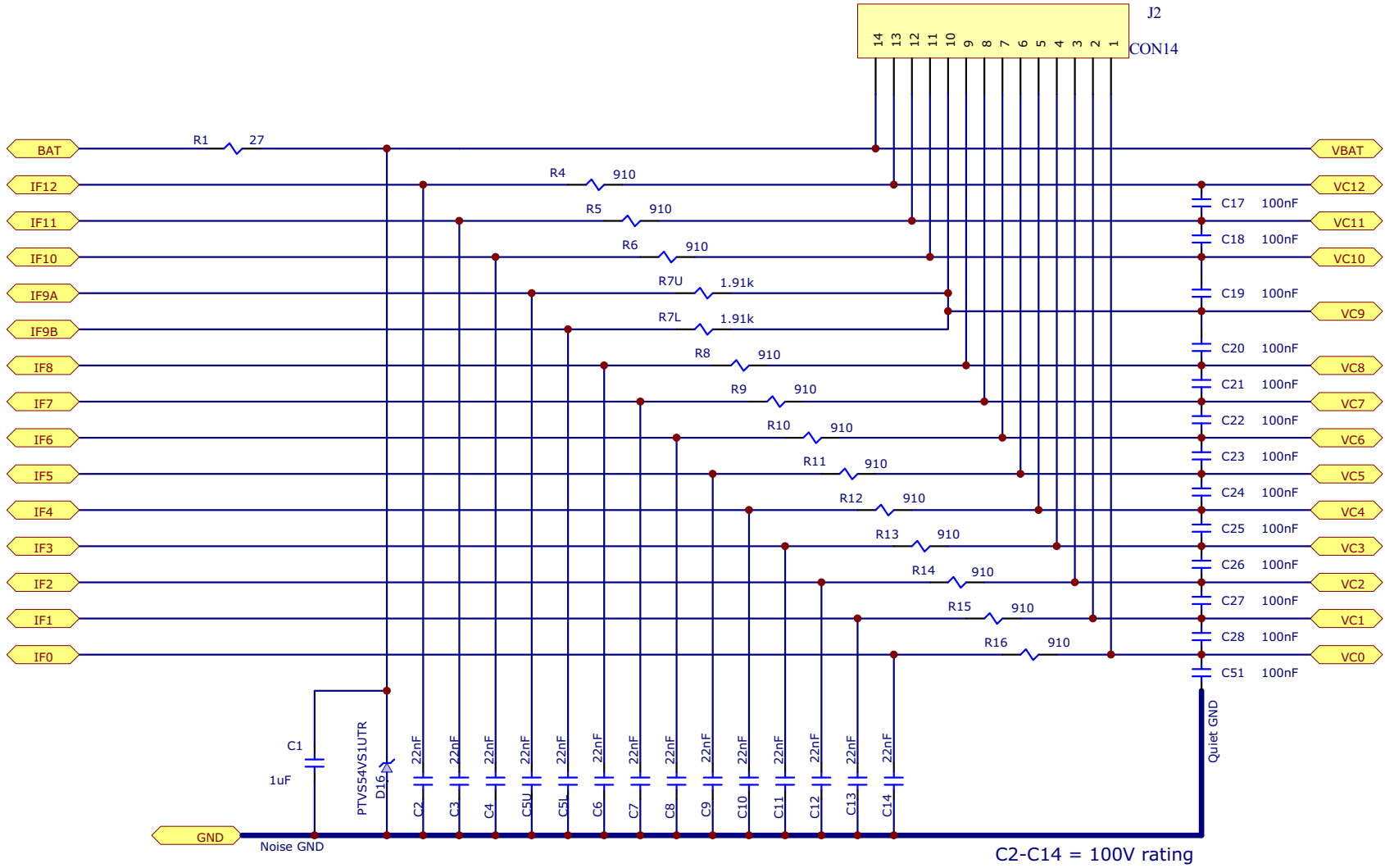


FIGURE 15. ISL78610EVAL2Z REVB BOARD CELL INPUT FILTER SCHEMATIC

Schematics (Continued)

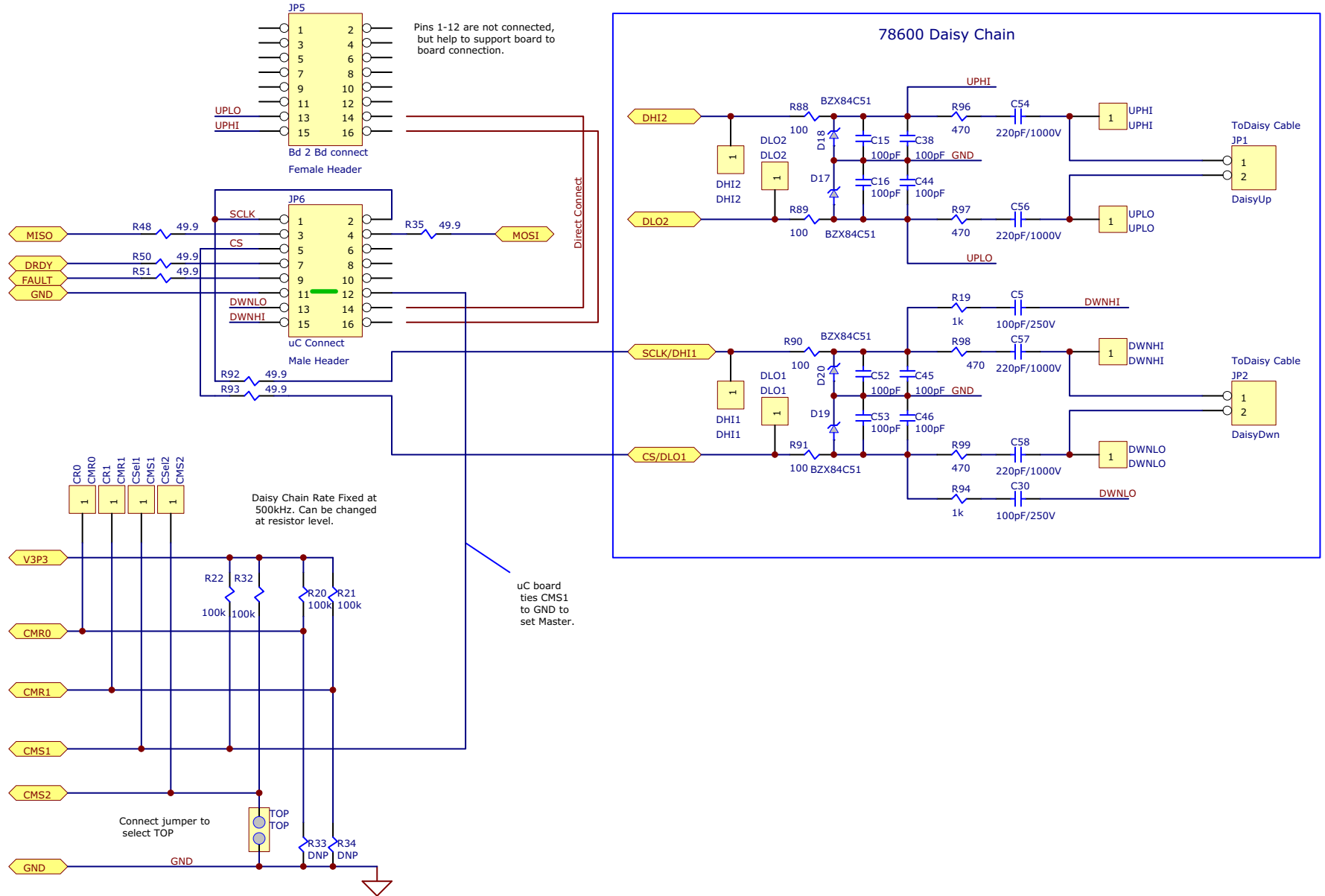


FIGURE 16. ISL78610EVAL2Z REV B BOARD COMMUNICATIONS SCHEMATIC

Schematics (Continued)

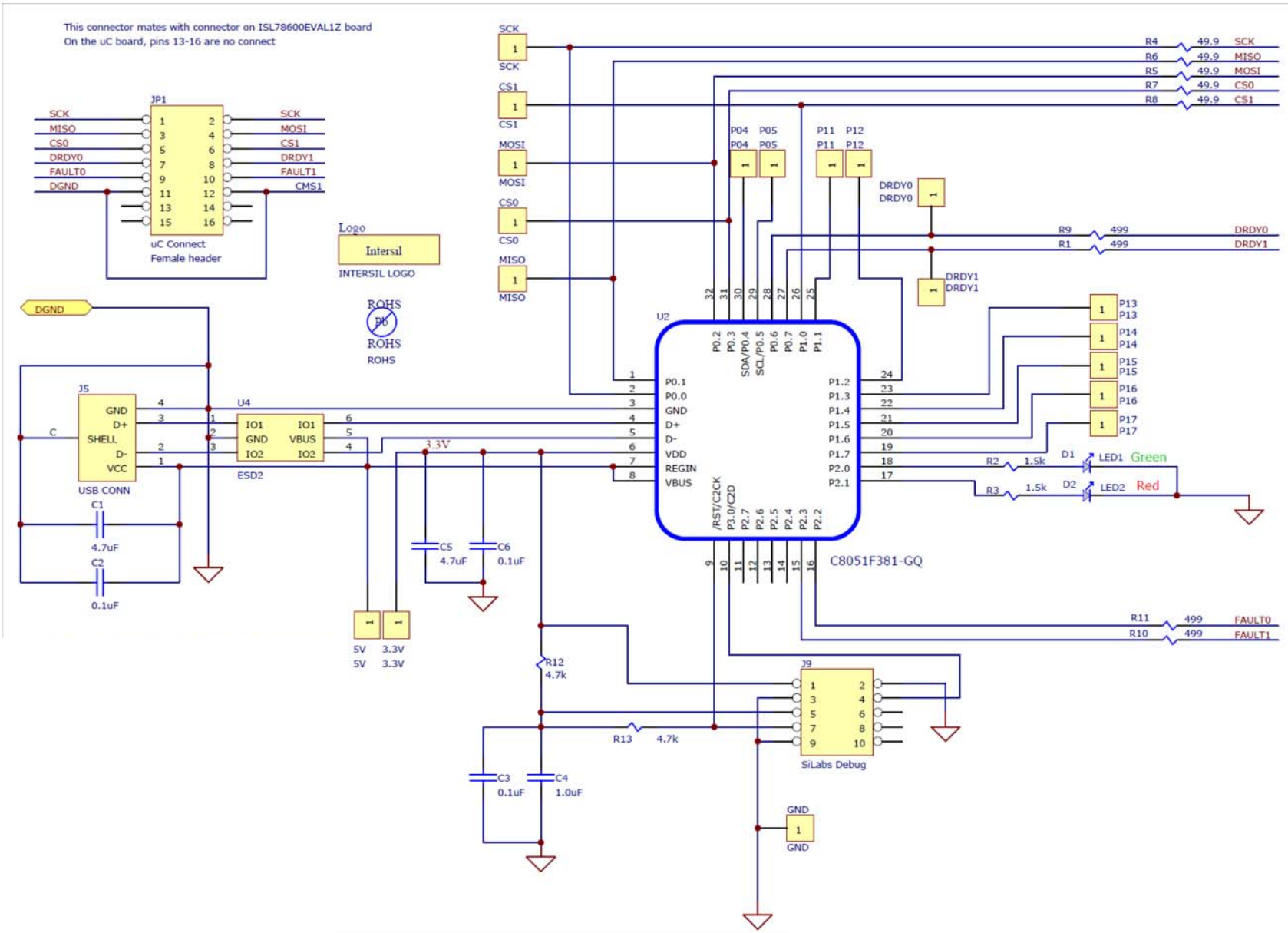
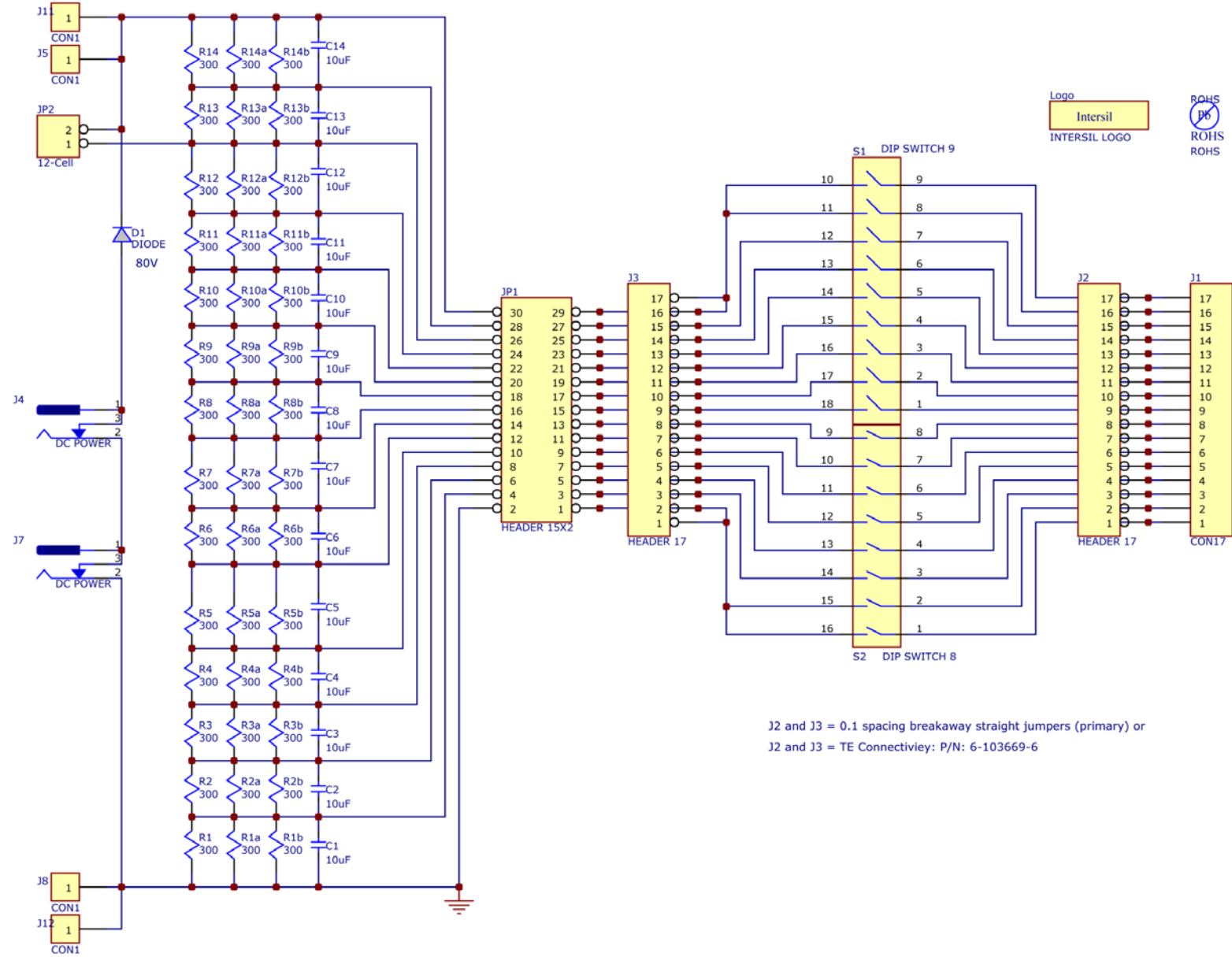


FIGURE 17. ISL78MICROEVZ REVD MICROCONTROLLER SCHEMATIC

Schematics (Continued)



J2 and J3 = 0.1 spacing breakout straight jumpers (primary) or
 J2 and J3 = TE Connectivity: P/N: 6-103669-6

FIGURE 18. MCB_PS3_Z POWER SUPPLY BOARD SCHEMATIC

Bill of Materials

QTY	REFERENCE DESIGNATOR	DESCRIPTION	MANUFACTURER	MANUFACTURER PART
ISL78610EVAL2Z REVB EVALUATION BOARD BOM				
1		PWB-PCB, ISL78610EVAL2Z, REVB, ROHS	IMAGINEERING INC	ISL78610EVAL2ZREVBPCB
1	C43	CAP, SMD, 0603, 2.2µF, 10V, 10%, X7R, ROHS	MURATA	GRM188R71A225KE15D
8	C15, C16, C38, C44, C45, C46, C52, C53	CAP, SMD, 0603, 100pF, 100V, 5%, NP0, ROHS	PANASONIC	ECJ-1VC2A101J
18	C29, C35-C37, C40a, C42a, C101-C112	CAP, SMD, 0603, 0.01µF, 16V, 10%, X7R, ROHS	VENKEL	C0603X7R160-103KNE
13	C17-C28, C51	CAP, SMD, 0603, 0.1µF, 100V, 10%, X7R, ROHS	VENKEL	C0603X7R101-104KNE
3	C40, C41, C42	CAP, SMD, 0603, 1.0µF, 10V, 10%, X7R, ROHS	AVX	0603ZC105KAT2A
14	C2-C4, C6-C14, C5L, C5U	CAP, SMD, 0603, 0.022µF, 100V, 10%, X7R, ROHS	VENKEL	C0603X7R101-223KNE
1	C39	CAP, SMD, 1206, 1µF, 100V, 10%, X7R, ROHS	VENKEL	C1206X7R101-105KNE
1	C1	CAP, SMD, 1812, 1.0µF, 100V, 10%, X7R, ROHS	VENKEL	C1812X7R101-105KNE
4	C54, C56, C57, C58	CAP, SMD, 0805, 220pF, 1000V, 5%, COG, ROHS	VISHAY/VITRAMON	VJ0805A221JXGAT5Z
2	C5, C30	CAP, SMD, 0805, 100pF, 250V, 5%, COG, ROHS	MURATA	GRM21A5C2E101JW01D
4	AGND1-AGND4	CONN-MINI TEST PT, VERTICAL, BLK, ROHS	KEYSTONE	5001
1	J7	CONN-HEADER, 2x4, BRKAWY-2x36, 2.54mm, ROHS	BERG/FCI	67996-272HLF
2	LEDEN, TOP	CONN-HEADER, 1x2, BRKAWY 1x36, 2.54mm, ROHS	BERG/FCI	68000-236HLF
1	J1	CONN-HEADER, 1x3, BREAKAWY 1x36, 2.54mm, ROHS	BERG/FCI	68000-236HLF
2	JP1, JP2	CONN-HEADER, SHROUDED, TH, 2POS, 2.54mm, R/A, ROHS	MOLEX	70555-0036
1	ExVDD-VREF-V2P5-VCC-V3P3	CONN-HEADER, 1x5, BRKAWY 1x64, 2.54mm, 0.195x0.118, ROHS	MILL-MAX	800-10-064-10-001000
1	J2	CONN-HDR, 1x14, BRKAWY 1Xx64, 2.54mm, 0.195x0.118.ROHS	MILL-MAX	800-10-064-10-001000
1	J5	CONN-HDR, 1x15, BRKAWY 1x64, 2.54mm, 0.195x0.118.ROHS	MILL-MAX	800-10-064-10-001000
1	JP6	CONN-HEADER, 2x8, BRKAWY 2x36, R/A, 2.54mm, GOLD, ROHS	SULLINS	PEC36DBAN
1	J3	CONN-HEADER, 1x17, BRKAWY 1x36, R/A, 2.54mm, GOLD, ROHS	SULLINS	PEC36SBAN
1	JP5	CONN-SOCKET, TH, 16P, 2x8, R/A, INSULATED, 2.54mm, ROHS	SULLINS	PPTC082LJBN-RC
3	LEDEN, EN(Enable), TOP	CONN-JUMPER, SHORTING, 2PIN, BLACK, GOLD, ROHS	SULLINS	SPC02SYAN
1	D16	TVS-AEC-Q101, ZENER DIODE, SMD, SOD-123W, 54V, 4.6A, ROHS	NXP SEMICONDUCTOR	PTVS54VS1UTR,115
2	D1, D3	LED-SMART, SMD, 0603, GREEN, 1.7V, 2mA, 570nm, 3.9mcd, ROHS	OSRAM	LGL29K-G2J1-24-Z
1	D2	LED-SMART, SMD, 0603, 2P, RED, 1.8V, 2mA, 630nm, 4.5mcd, ROHS	OSRAM	LSL29K-G1J2-1-0-2-R18-Z
12	D4-D15	LED-SMART, SMD, 0603, YELLOW, 1.8V, 2mA, 587nm, 7.9mcd, ROHS	OSRAM	LY L29K-J1K2-26-Z
4	D17-D20	DIODE, ZENER, SMD, 2P, SOT23-3, 51V, 300mA, ROHS	DIODES, INC.	BZX84C51
1	U1	IC-LI-ON BATTERY MANAGER, 64P, TQFP, ROHS	INTERSIL	ISL78610ANZ
4	R27-R30	THERMISTOR-NTC, SMD, 0402, 10k, 1/10W, 5%, ROHS	MURATA	NCP15XH103J03RC

Bill of Materials (Continued)

QTY	REFERENCE DESIGNATOR	DESCRIPTION	MANUFACTURER	MANUFACTURER PART
1	Q1	TRANSISTOR, NPN, 4P, SOT-223, 80V, 1A, 1W, ROHS	DIODES, INC.	DCP56-16-13
9	Q3-Q11	TRANSISTOR-MOS, N-CHANNEL, SMD, SOT23, 60V, 1.6A, ROHS	DIODES INC.	DMN6140L-7
3	Q12, Q13, Q14	TRANSISTOR-MOS, P-CHANNEL, SMD, SSOT3, -60V, -1.2A, ROHS	FAIRCHILD	FDN5618P
12	R4A-R15A	RES, SMD, 0402, 0Ω, 1/16W, 5%, TF, ROHS	VENKEL	CR0402-16W-00T
30	R7, R17, R18, R64-R75	RES, SMD, 0402, 1k, 1/16W, 1%, TF, ROHS	VENKEL	CR0402-16W-1001FT
4	R23-R26	RES, SMD, 0402, 10k, 1/16W, 1%, TF, ROHS	PANASONIC	ERJ-2RKF1002X
4	R20, R21, R22, R32	RES, SMD, 0402, 100k, 1/16W, 1%, TF, ROHS	PANASONIC	ERJ2RKF1003
0	R33, R34	RES, SMD, 0402, DNP, DNP, DNP, TF, ROHS		
1	R2	RES, SMD, 0603, 33Ω, 1/10W, 1%, TF, ROHS	VENKEL	CR0603-10W-33R0FT
6	R3, R16A, R88-R91	RES, SMD, 0603, 100Ω, 1/10W, 1%, TF, ROHS	VENKEL	CR0603-10W-1000FT
6	R35, R48, R50, R51, R92, R93	RES, SMD, 0603, 49.9, 1/10W, 1%, TF, ROHS	YAGEO	RC0603FR-0749R9L
12	R36-R47	RES, SMD, 0603, 10k, 1/10W, 1%, TF, ROHS	VENKEL	CR0603-10W-1002FT
1	R49	RES, SMD, 0603, 100k, 1/10W, 1%, TF, ROHS	VENKEL	CR0603-10W-1003FT
2	R7L, R7U	RES, SMD, 0603, 1.82k, 1/10W, 1%, TF, ROHS	PANASONIC	ERJ-3EKF1821V
12	R76-R87	RES, SMD, 0603, 330k, 1/10W, 1%, TF, ROHS	YAGEO	RC0603FR-07330KL
4	R96, R97, R98, R99	RES, SMD, 0603, 470Ω, 1/10W, 1%, TF, ROHS	ROHM	MCR03EZPFX4700
15	R4-R6, R8-R16	RES, SMD, 0603, 910Ω, 1/10W, 1%, TF, ROHS	YAGEO	RC0603FR-07910RL
0	R4B-R15B	RES, SMD, 0603, DNP-PLACE HOLDER, ROHS		
3	R19, R94	RES, SMD, 0603, 1k, 1/10W, 1%, TF, ROHS	PANASONIC	ERJ-3EKF1001V
1	R1	RES, SMD, 0805, 27Ω, 1/8W, 1%, TF, ROHS	PANASONIC	ERJ-6ENF27R0V
1	R31	RES, SMD, 1206, 100Ω, 1/4W, 1%, TF, ROHS	STACKPOLE	RMC1/8 100R 1% T/R
12	R52-R63	RES, SMD, 1210, 100Ω, 1/2W, 1%, TF, ROHS	PANASONIC	ERJ-14NF1000U
ISL78MICROEVZ REVD MICROCONTROLLER BOARD BOM				
1		PWB-PCB, MCB_MICRO_EVZ, REVD, ROHS	IMAGINEERING INC	MCB_MICRO_EVZREVDPCB
3	C2, C3, C6	CAP, SMD, 0603, 0.1μF, 16V, 10%, X7R, ROHS	MURATA	GRM39X7R104K016AD
1	C4	CAP, SMD, 0603, 1.0μF, 10V, 10%, X7R, ROHS	AVX	0603ZC105KAT2A
2	C1, C5	CAP, SMD, 0603, 4.7μF, 10V, 10%, X5R, ROHS	VENKEL	C0603X5R100-475KNE
1	J5	CONN-USB TYPE B, RECEPTACLE, PCB MNT, R/A, ROHS	ASSMANN ELECTRONICS INC	AU-Y1007-R
1	JP1	CONN-RECEPTACLE, TH, 2x8, 2.54mm, R/A, TIN, ROHS	SULLINS	PPPC082LJBN-RC
1	U2	IC-USB μCONTROLLER, 78600-V7.2 PROGRAM, 32P, LQFP, ROHS	SILICON LABORATORIES	C8051F381-GQ
1	U4	IC-TVS, ESD PROTECTOR, SMD, 6P, SOT-23-6L, 3pF, 6V, ROHS	STMICROELECTRONICS	USBLC6-2SC6

Bill of Materials (Continued)

QTY	REFERENCE DESIGNATOR	DESCRIPTION	MANUFACTURER	MANUFACTURER PART
4	R1, R9, R10, R11	RES, SMD, 0402, 499Ω, 1/16W, 1%, TF, ROHS	VENKEL	CR0402-16W-4990FT
2	R12, R13	RES, SMD, 0603, 4.7k, 1/10W, 1%, TF, ROHS	YAGEO	9C06031A4701FKHFT
2	R2, R3	RES, SMD, 0402, 1.5k, 1/10W, 1%, TF, ROHS	PANASONIC	ERJ-2RKF1501X
6	R4-R8	RES, SMD, 0402, 49.9, 1/10W, 1%, TF, ROHS	YAGEO	RC0402FR-0749R9L
1	D1	LED-SMART, SMD, 0603, GREEN, 1.7V, 2mA, 570nm, 3.9mcd, ROHS	OSRAM	LGL29K-G2J1-24-Z
1	D2	LED-SMART, SMD, 0603, 2P, RED, 1.8V, 2mA, 630nm, 4.5mcd, ROHS	OSRAM	LSL29K-G1J2-1-0-2-R18-Z
0	Do Not Populate (J9)	CONN-HEADER, 2x4, BRKAWY-2x36, 2.54mm, ROHS	BERG/FCI	67996-272HLF
0	Do Not Populate (5V, 3.3V, GND, DRDY1, DRDY0, CS0, CS1, MISO, MOSI, SCK, P04, P05, P11, P12, P15-P17)	CONN-HEADER, 1x1, BRKAWY 1x64, 2.54mm, 0.195x0.118, ROHS"	MILL-MAX	800-10-064-10-001000
1	C43	CAP, SMD, 0603, 2.2μF, 10V, 10%, X7R, ROHS	MURATA	GRM188R71A225KE15D
MCB_PS3_Z POWER SUPPLY BOARD BOM				
1		PWB-PCB, MCB_PS3_Z, REVA, ROHS	TBD	MCB_PS3_ZREVAPCB
42	R1-R14, R1a-R14a, R1b-R14b	RES, SMD, 1206, 300Ω, 0.33W, 1%, TF, ROHS	VISHAY/DALE	CRCW2513300RFKEG
14	C1-C14	CAP, SMD, 1206, 10μF, 16V, X7R, ROHS	VENKEL	C1206X5R160-106KNE
1	D1	Diode, Schottky, 80V, 0.5A SOD123	Micro Commercial	MBR0580-TP
1	S1	SWITCH-DIP, SPST, SMD, 9POS, TOP ACTUATE, ROHS	E-SWITCH	KAE09LGGT
1	S2	SWITCH-DIP, SPST, SMD, 8POS, TOP ACTUATE, ROHS	E-SWITCH	KAE08LGGT
3	J11, J12	CONN-COMPACT TEST POINT, SMD, ROHS	KEystone	5016
1	JP1	CONN-HEADER, 2x15, BRKAWY 2x36, 2.54mm, ROHS	BERG/FCI	67996-272HLF
1	JP2	CONN-HEADER, 1x2, BRKAWY 1x36, 2.54mm, ROHS	BERG/FCI	68000-236HLF
2	J2, J3	CONN-HEADER, 1x17, BREAKAWY 1x36, 2.54mm, ROHS	BERG/FCI	68000-236HLF
1	J1	CONN-RECEPTACLE, TH, 1x17, 2.54mm, R/A, TIN, ROHS	SULLINS	PPTC131LGBN-RC
2	J4, J7	CONN JACK POWER 2.1mm PCB	CUI, Inc.	PJ-102A
16	JP1-Pos 1-15, JP2	CONN-JUMPER, SHORTING, 2PIN, BLACK, GOLD, ROHS	SULLINS	SPC02SYAN
0	DO NOT POPULATE: J5	CONN-GEN, BIND. POST, INSUL-RED, THMBNUT-GND	JOHNSON COMPONENTS	111-0702-001
0	DO NOT POPULATE: J8	CONN-GEN, BIND. POST, INSUL-BLK, THMBNUT-GND	JOHNSON COMPONENTS	111-0703-001

PCB Layout

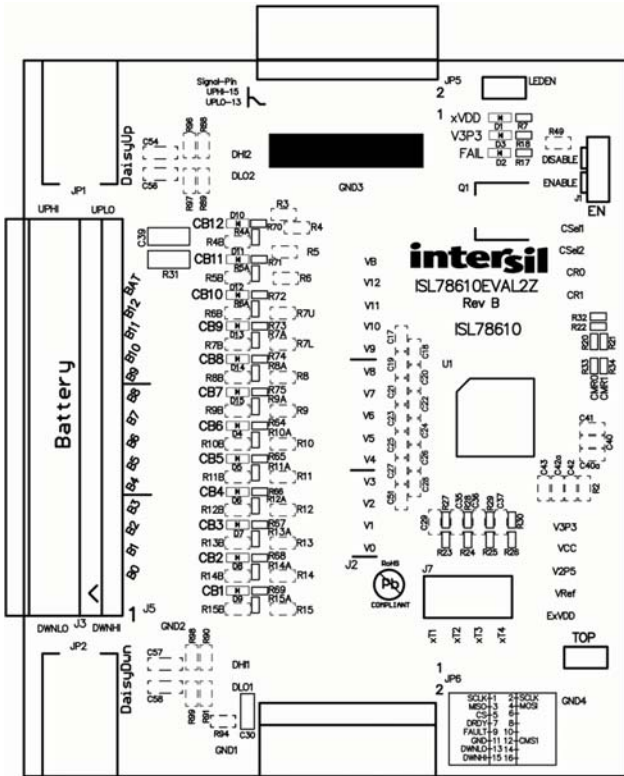


FIGURE 19. ISL78610EVAL2Z REVB TOP OVERLAY

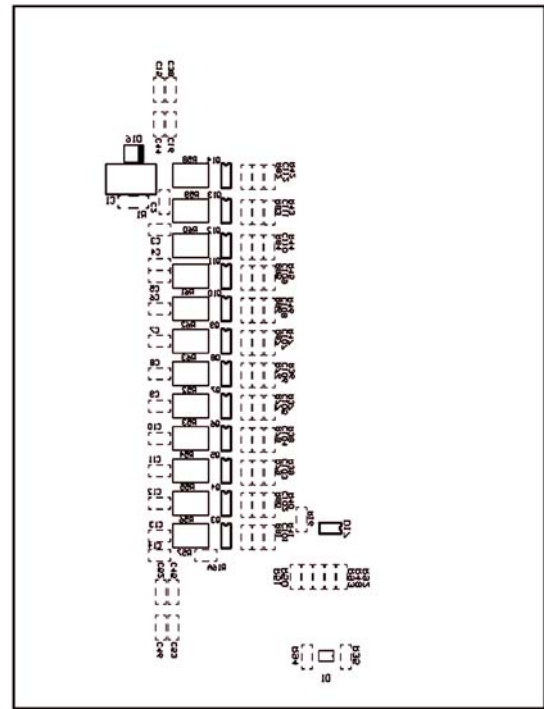


FIGURE 20. ISL78610EVAL2Z REVB BOTTOM OVERLAY

PCB Layout (Continued)

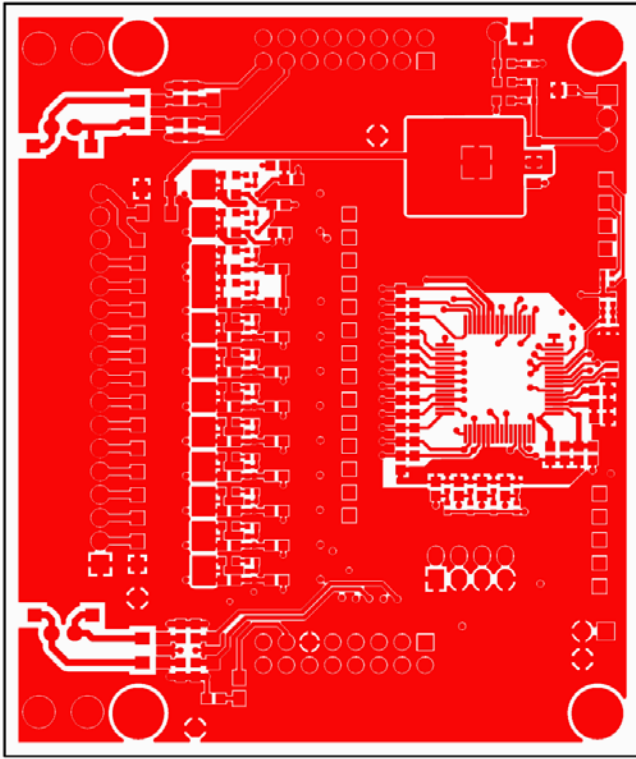


FIGURE 21. ISL78610EVAL2Z REV B TOP LAYER

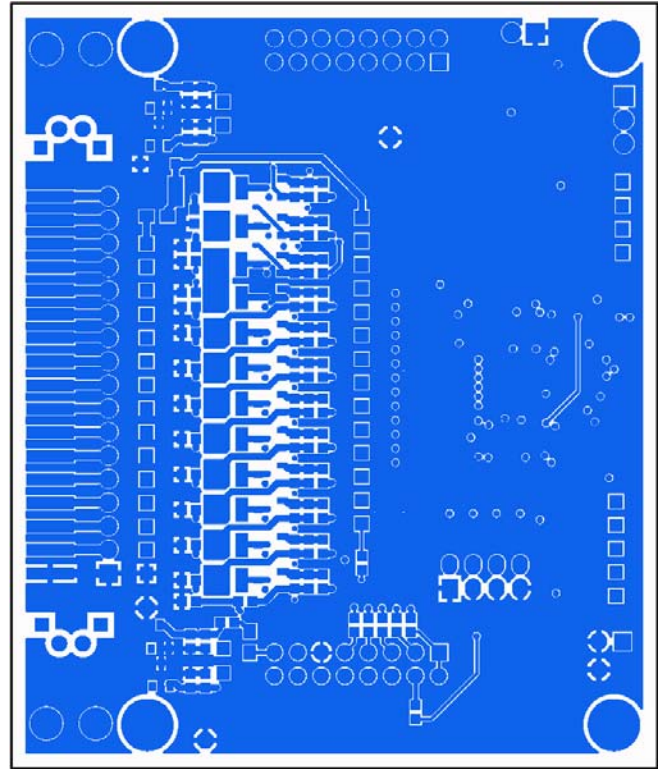


FIGURE 22. ISL78610EVAL2Z REV B BOTTOM LAYER

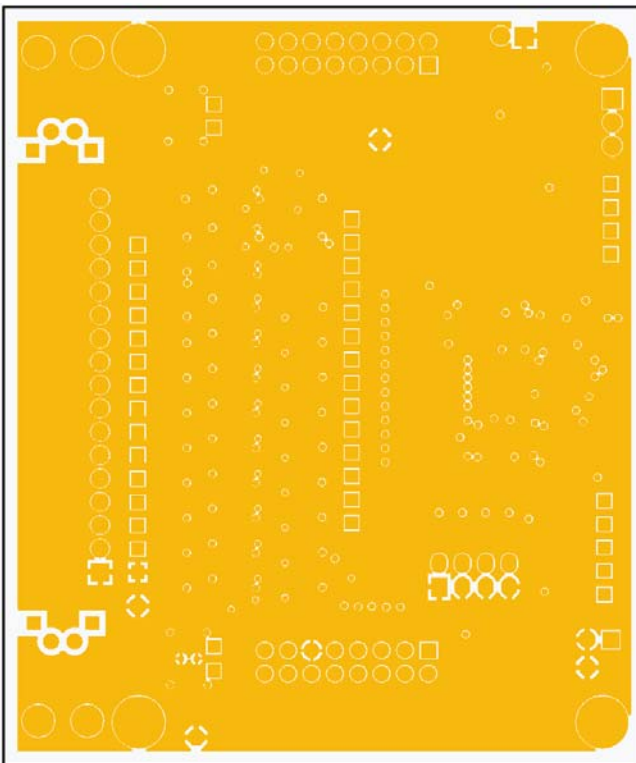


FIGURE 23. ISL78610EVAL2Z REV B MID1 LAYER

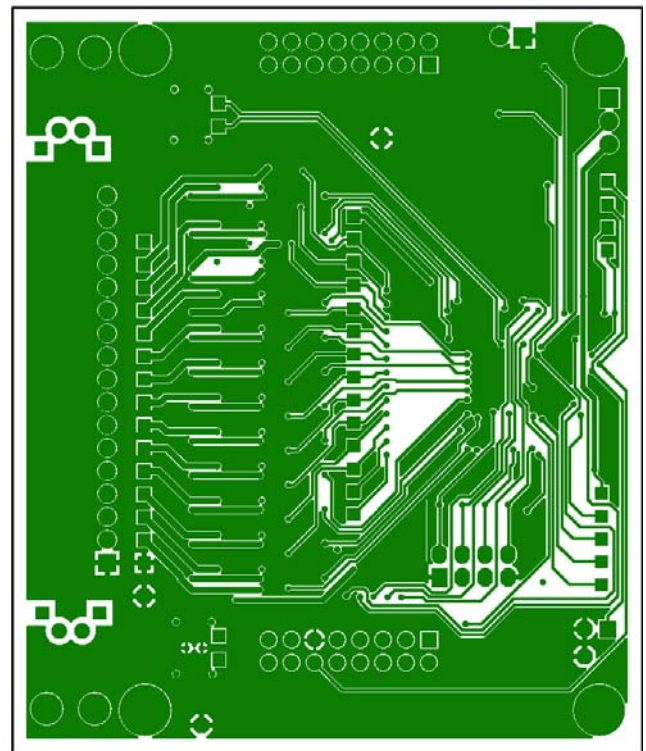


FIGURE 24. ISL78610EVAL2Z REV B MID2 LAYER

PCB Design Guidelines

Referring to [Figures 14 and 15 on page 17](#) (battery connection circuits), the first stage of the input filter provides protection against transients and EMI for the cell inputs. They carry the loop currents produced by EMI and should be placed as close to the connector as possible. The ground terminals of the capacitors must be connected directly to a solid ground plane. Do not use vias to connect these capacitors to the input signal path or to ground. Any vias should be placed in line to the signal inputs so that the inductance of these form a low-pass filter with the grounded capacitors.

Referring to [Figure 14 on page 16](#), the daisy chain components are shown in the top right of the drawing. These are split into two sections. Components to the right of this section should be placed close to the board connector with the ground terminals of capacitors connected directly to a solid ground plane. This is the same ground plane that serves the cell inputs. Components to the left of this section should be placed as closely to the device as possible.

The battery connector and daisy chain connectors should be placed closely to each other on the same edge of the board to minimize any loop current area.

Two grounds are identified on the circuit diagram. These are nominally referred to as noisy and quiet grounds. The noisy ground, denoted by an “earth” symbol, carries the EMI loop currents and digital ground currents. The quiet ground is used to define the decoupling voltage for voltage reference and the analog power supply rail. The quiet and noisy grounds should be joined at the VSS pin. Keep the quiet ground area as small as possible.

The circuits shown at the bottom of [Figure 13 on page 15](#) provide external temperature inputs. These inputs are designed to operate with on-board NTC thermistors. If external thermistors are desired, either remove the on-board thermistors or replace them with 10k resistors.

Each of the external inputs has an internal pull-up resistor, which is connected by a switch to the VCC pin whenever the TEMPREG output is active. This arrangement results in an open input being pulled up to the V_{CC} voltage.

Component Selection

Certain failures associated with external components can lead to unsafe conditions in electronic modules. A good example of this is a component that is connected between high energy signal sources failing short. Such a condition can easily lead to the component overheating and damaging the board and other components in its proximity.

One area to consider with the external circuits on the ISL78610 is the capacitors connected to the cell monitoring inputs. These capacitors are normally protected by the series protection resistors but could present a safety hazard in the event of a dual point fault where both the capacitor and associated series resistor fail short. Also, a short in one of these capacitors would dissipate the charge in the battery cell if left uncorrected for an extended period of time. It is recommended that input capacitors connecting directly to ground be selected to be “fail safe” or

“open mode” types. An alternative strategy would be to replace each of these capacitors with two devices in series, each with double the value of the single capacitor.

A dual point failure in the balancing resistors of [Figure 14 on page 16](#) and associated balancing MOSFET could also give rise to a shorted cell condition. It is recommended that the balancing resistor be replaced by two resistors in series.

The layout of the ISL78610EVAL2Z RevB board attempts to:

1. Minimize the placement of signals on inner layers that might exceed the voltage limits on the board. Specifically, these include the daisy chain signals on the cable side of the isolation capacitors. Inner layers do not have as much isolation as external layers.
2. Minimize the placement on outer layers, the traces carrying signals to and from the ISL78610. This is to minimize the effects of radiation-induced voltages on board circuitry.
3. Minimize the effect of temperature-induced stress on the IC during flow solder via the absence of a ground plane on the top layer under the IC. However, a middle and bottom layer do contain ground layers to protect the circuits on the board from radiation-induced voltages.
4. Allow extra space around the daisy chain signals that might experience higher voltages when the boards are cascaded.

Evaluation Board Design Details

In the ISL78610EVKIT1Z Evaluation kit:

1. The microcontroller board is split from the evaluation board. The μ C board is designed to automatically select the board connected to it as the master. To do this, the mode select bits CMS1 and CMS2 on the ISL78610EVAL2Z board are pulled up to local V3P3 voltages, thus automatically setting them as mid devices - absent any other connection. When an evaluation board connects to the microcontroller board, CMS1 is pulled low through the connector making this evaluation board the master. The top device is selected by placing a shunt on the “TOP” jumper, which pulls CMS2 low.

This configuration eliminates the switches in the original design.

If the system uses an external controller, it is easier to eliminate the Intersil microcontroller. But, when connecting to an external microcontroller, remember to connect together pins 11 and 12 of the ISL78610EVAL2Z board JP6 connector.

This arrangement allows for a smaller evaluation board form factor.

2. The CMR1 and CMR0 inputs are set to “1” by on-board resistors. These set the daisy chain speed to 500kHz. If slower speeds are desired, these resistors need to change. Remember that changing daisy speeds requires changes to the capacitors in the daisy chain link. To switch to slower daisy chain speeds, check the datasheet for changes to the daisy chain capacitor values for the selected changes to the CMR resistors. These changes will require removal and replacement of soldered components on the PCB.

3. Daisy chain operation can be set with direct board-to-board connection of the daisy chain or with daisy chain cables. These connections use identical circuits.
4. The external MCB_PS3_Z board has power switches. These can be used to experiment with open-wire conditions.
5. The power supply board (MCB_PS3_Z) to evaluation board connection provides direct connection to the ISL78610EVAL2Z board without a cable. If a cable connection between the evaluation board and a battery stack is desired, remove the J3 connector on the evaluation board and replace it with a different type. One recommended option for cable connection components is:
Vendor: TE Connectivity
PCB connector part number: 6-104935-6
Mates to Cable connector part number: 1-104257-6
Cable connector pins part number: 1-104480-7
Cable Wire: 3M 8124 series
6. The MCB_PS3_Z board was designed to allow connection of two 24V regulators. When two regulators connect, the evaluation board is powered by 48V. The connectors used have a “break-before-make” configuration, so removing or adding a second supply will cause a power reset.
If this board is to be used with an external power supply at a voltage greater than 40V and at temperatures higher than 60 °C, remove the diode. It cannot handle reverse voltage differential at these higher temperatures.
7. In the default configuration, the board monitors the cells after the cell balance resistor.
In this default condition, turning on a cell balance input pulls the input voltage low, so monitoring that input returns near 0V. This is the preferred configuration for safety coverage, since the system can check this voltage to confirm that the input circuit and cell balance components are working correctly.
When using the MCB_PS3_Z board, turning on a cell balance output will likely also change the voltage at the other cells, because the cell balance connects a 100Ω resistor in parallel with the MCB+PS3_Z boards 100Ω series divider resistor.
If this is not the desired cell connection, the board can be modified to monitor the cells directly at the board input pins. This involves removing some resistors and adding others. To do this, remove resistors R_{4A} to R_{15A} (0Ω) and populate resistors R_{5B} to R_{15B} (100Ω).
8. The ISL78610EVAL2Z board has a resistor divider and thermistors on the board for external temperature measurement. The resistor divider is set-up for the specific Murata thermistor specified in the BOM. If it is desired to connect thermistors off board, remove the thermistors (R₂₇ to R₃₀) or replace them with resistors equal in value to the external thermistors. Also, if the external thermistors differ in room temperature resistance, it might also be necessary to replace the upper resistor in the divider (R₂₃ to R₂₆) with more appropriate valued ones. If it is desired to use the ExTn inputs for monitoring a voltage, remove the on-board thermistors (R₂₇ to R₃₀) and the upper divider resistors (R₂₃ to R₂₆) and apply a voltage directly to the pins on J7. Measurement happens in response to a Scan Temperatures command.

References

For further information on the board, the features of the GUI or functions of the microcontroller code, refer to the [ISL78610](#) datasheet.

Q&A

1. When I click to start the GUI, nothing happens, I cannot connect to the boards.

The most common problem encountered when setting up the boards is a connection error. This is seen after clicking on the connect button and Device Present “PRES” indicators do not turn Green. The activity log at the bottom of the screen also indicates that one or more of the devices cannot be found.

If this happens, check that all of the cables are connected properly.

- For a stand-alone configuration, make sure that there is a shunt on the “TOP” jumper.
- For a daisy chain configuration, make sure the “TOP” jumpers are populated as shown in [Figure 3 on page 6](#). That is, only the top board should have a shunt on the “TOP” jumper.
- Make sure that the daisy chain cables are connected to the proper device. That is, the DaisyUp connects to DaisyDwn. Make sure that the connections look like those in [Figure 3 on page 6](#).
- Check that the USB cable is plugged in and that the PC detects the USB connection.
- Check that the V_{BAT} voltages are all within specified limits.
- Check that the ISL78610 enable jumper is in place.
- Inspect the LEDs to identify if all boards are powered properly. If the V3P3 LED is on, but the xVDD LED is off, the device is most likely in a sleep state. If both LEDs are off, the part is not powered or disabled. However, it would be a good idea if there is a communication problem not solved by the above, to check the voltage on the V3P3 and VREF pins. The V3P3 should be 3.3V and the VREF should be 2.5V. If they are not, then there could be a board problem and you should contact your Intersil representative.
- You could try placing the TOP jumper on a lower board (starting from the master) and moving it up, board by board, until communication fails. This requires restarting the GUI, but it will indicate if there is a daisy chain hardware component failure or bad cable.

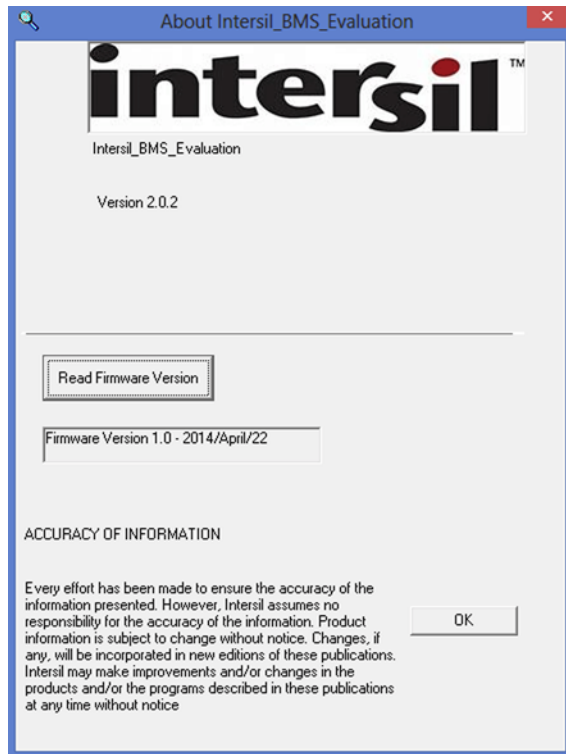
2. When I enable Polling, the voltages do not update.

When the GUI starts, there are no items selected for polling. Click on the “Polling Setup” button and click on the “Quick Setup” button. This enables the most common measurement operations.

3. When I check an open-wire condition on VC1, VC2, or VC3 by using the switches on the board, the open-wire condition is not detected.

When the ISL78610 powers up, the open-wire current is set to 100 μ A by default. This current is not high enough to discharge the input capacitors on these three inputs in the time allowed. For the proper open-wire operation on the ISL78610EVAL2Z board, it is necessary to set the *ISCN* bit to “1”. This bit is found in the “Dev. Setup” register on the “Setup2” tab.

4. When contacting the factory with questions, click on the “About” menu item and click on read firmware version and send the GUI and firmware version with your question. See example below.



5. I directly connected two ISL78610EVAL2Z boards together in a Daisy Chain configuration and I cannot get Daisy Chain communication working.

Make sure that you are not connecting an ISL78610EVAL2Z RevA board to an ISL78610EVAL2Z RevB board. The RevA and RevB boards are not compatible in the direct connect daisy chain configuration on the RevA board, the circuit for direct connection was the same as for cable connection. As such, it has a series capacitor on both sides of the connection. This is important when a cable is used to isolate the wire if there is a break in the wire or a short to the chassis. However, an on-board connection between two devices does not need both sides to be the same. So, the RevB board removed the capacitor and resistor from one side of the connection. The new series capacitor is 100pF, instead of the previous 220pF, and the new series resistor is 1k Ω instead of 470 Ω . To get communication working between a RevA and RevB board, try using the cable connection.

Errata

GUI

When performing an ISL78610 “Read Group” or a Read “Cells in Balance” register, the GUI returns a NACK response. This is normal, because the ISL78610 “Cells in Balance” register was not implemented correctly, so it does not know how to handle the request. Please ignore this fault.

EVALUATION BOARD

There was a error in the design of the evaluation board.

Diodes D17 and D19 in [Figure 16](#) on [page 18](#) are connected with the wrong polarity. These parts were removed from the board and should not be populated. This is not a problem for normal board operation. They were included for Daisy Chain ESD requirements that exceed 4kV.

Typical Performance Curves

Unless noted: V_{Batt} 24V or 48V as designated, $T_A = +25^\circ\text{C}$. Curves provided are based on exported data from the ISL78610 GUI software. Measurements are captured from three ISL78610 devices operating in daisy chain mode. Charts are based on either 24V or 48V battery voltage. Measurements are taken with time being the x-axis. This provides information regarding typical subsystem reading variation. Some graphs provide device to device comparisons as well.

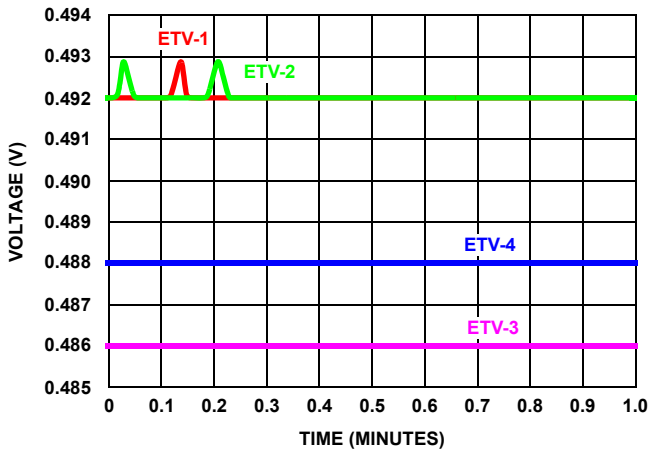


FIGURE 25. ETV1-4 DEVICE 1 48V

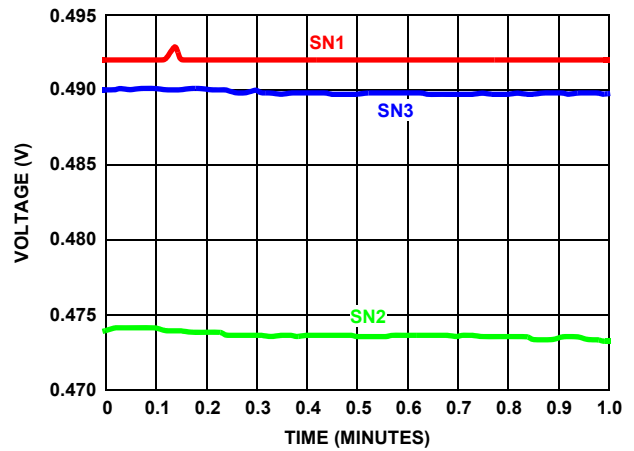


FIGURE 26. ETV1 DEVICE TO DEVICE SPREAD 48V

Internal Temperature

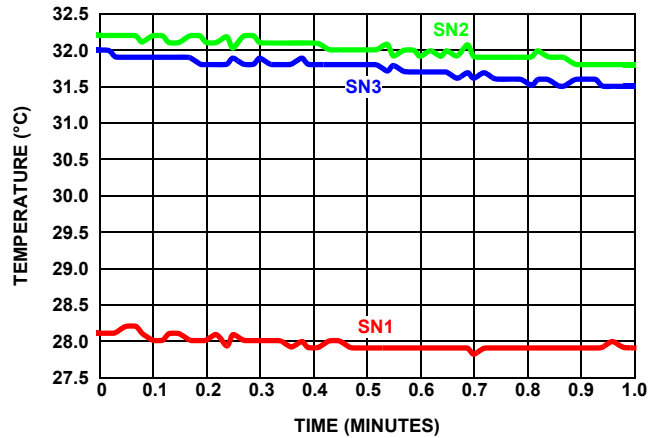


FIGURE 27. INTERNAL TEMPERATURE DEVICE TO DEVICE SPREAD 24V

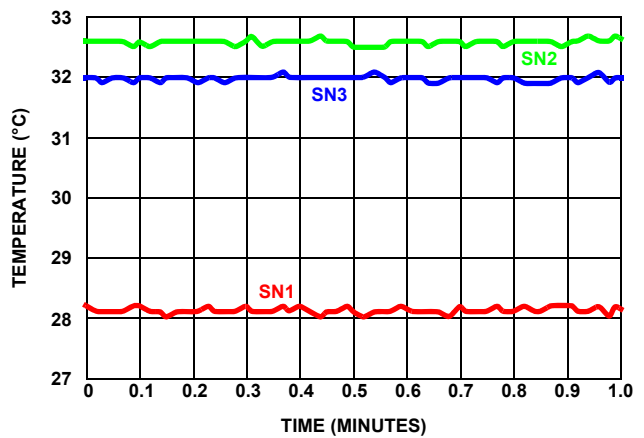


FIGURE 28. INTERNAL TEMPERATURE DEVICE TO DEVICE SPREAD 48V